## 1. Overview

### 1.1 Features

The R8C/3MQ Group single-chip MCU functions as a low-power-consumption transceiver which supports 2.4 GHz compliant to IEEE802.15.4 standard and incorporates the R8C CPU core, employing sophisticated instructions for a high level of efficiency. With 1 Mbyte of address space, and it is capable of executing instructions at high speed. In addition, the CPU core boasts a multiplier for high-speed operation processing.
Power consumption is low, and the supported operating modes allow additional power control.
Integration of many peripheral functions, including multifunction timer and serial interface, reduces the number of system components.
The R8C/3MQ Group has data flash ( $1 \mathrm{~KB} \times 4$ blocks) with the background operation (BGO) function.

### 1.1.1 Applications

Electronic household appliances, office equipment, audio equipment, consumer equipment, etc.

### 1.1.2 Specifications

Tables 1.1 and 1.2 outline the Specifications for R8C/3MQ Group.
Table 1.1 Specifications for R8C/3MQ Group (1)

| Item | Function | Specification |
| :---: | :---: | :---: |
| CPU | Central processing unit | R8C CPU core <br> - Number of fundamental instructions: 89 <br> - Minimum instruction execution time: $\begin{aligned} & 62.5 \mathrm{~ns}(f(\mathrm{BCLK})=16 \mathrm{MHz}, \mathrm{VCC}=2.7 \text { to } 3.6 \mathrm{~V}) \\ & 125 \mathrm{~ns}(f(\mathrm{f} C L K)=8 \mathrm{MHz}, \mathrm{VCC}=2.2 \text { to } 3.6 \mathrm{~V}) \\ & 250 \mathrm{~ns}(f(\mathrm{BCLK})=4 \mathrm{MHz}, \mathrm{VCC}=1.8 \text { to } 3.6 \mathrm{~V}) \end{aligned}$ <br> - Multiplier: 16 bits $\times 16$ bits $\rightarrow 32$ bits <br> - Multiply-accumulate instruction: 16 bits $\times 16$ bits +32 bits $\rightarrow 32$ bits <br> - Operation mode: Single-chip mode (address space: 1 Mbyte) |
| Memory | ROM, RAM, Data flash | Refer to Table 1.3 Product List for R8C/3MQ Group. |
| Power Supply Voltage Detection | Voltage detection circuit | - Power-on reset <br> - Voltage detection 2 (detection level of voltage detection 1 selectable) |
| 1/O Ports | Programmable I/O ports | CMOS I/O ports: 18 (including XCIN and XCOUT), selectable pull-up resistor (for some ports) |
| Clock | Clock generation circuits | - 3 circuits: XIN clock oscillation circuit, <br> XCIN clock oscillation circuit ( 32 kHz ), <br> Low-speed on-chip oscillator <br> - Oscillation stop detection: XIN clock oscillation stop detection function <br> - Frequency divider circuit: Dividing selectable 1, 2, 4, 8, and 16 <br> - Low power consumption modes: <br> Standard operating mode (high-speed clock, low-speed clock, low-speed on-chip oscillator), wait mode, stop mode |
|  |  | Real-time clock (timer RE) |
| Interrupts |  | - Interrupt Vectors: 69 <br> - External: 11 sources ( $\overline{\mathrm{NT}} \times 3$, key input $\times 8$ ) <br> - Priority levels: 7 levels |
| Watchdog Timer |  | - 14 bits $\times 1$ (with prescaler) <br> - Reset start selectable <br> - Low-speed on-chip oscillator for watchdog timer selectable |
| DTC (Data Transfer Controller) |  | - 1 channel <br> - Activation sources: 17 <br> - Transfer modes: 2 (normal mode, repeat mode) |
| Timer | Timer RA | 8 bits $\times 1$ (with 8 -bit prescaler) <br> Timer mode (period timer), pulse output mode (output level inverted every period), event counter mode, pulse width measurement mode, pulse period measurement mode |
|  | Timer RB | 8 bits $\times 1$ (with 8 -bit prescaler) <br> Timer mode (period timer), programmable waveform generation mode (PWM output), programmable one-shot generation mode, programmable wait one-shot generation mode |
|  | Timer RC | 16 bits $\times 1$ (with 4 capture/compare registers) <br> Timer mode (input capture function, output compare function), PWM mode (output 3 pins), PWM2 mode (PWM output pin) |
|  | Timer RE | 8 bits $\times 1$ <br> Real-time clock mode (count seconds, minutes, hours, days of week), output compare mode |

Table 1.2 Specifications for R8C/3MQ Group (2)

| Item | Function | Specification |
| :---: | :---: | :---: |
| Serial Interface (UART0) |  | Shared with clock synchronous serial I/O mode and clock asynchronous serial I/O |
| Synchronous Serial Communication Unit (SSU) |  | 1 (shared with $\mathrm{I}^{2} \mathrm{C}$ bus) |
| ${ }^{2} \mathrm{C}$ bus |  | 1 (shared with SSU) |
| RF | RF frequency | 2405 MHz to 2480 MHz |
|  | Reception sensitivity | $-95 \mathrm{dBm}$ |
|  | Transmission output level | 0 dBm |
| Baseband |  | - 127-byte transmit RAM, 127-byte receive RAM $\times 2$ <br> - Automatic ACK response function <br> - 26-bit timer: Compare function in 3 channels |
| Encryption | AES | AES Encryption/Decryption (Key length 128bits) |
| Flash Memory |  | - Programming and erasure voltage: VCC $=1.8$ to 3.6 V (in CPU rewrite mode) <br> - Programming and erasure endurance:10,000 times (data flash) <br> 1,000 times (program ROM) <br> - Program security: ROM code protect, ID code check <br> - Debug functions: On-chip debug, on-board flash rewrite function <br> - Background operation (BGO) function |
| Operating F Supply Volt | quency/ <br> (in single mode) | $\begin{aligned} & \mathrm{f}(\mathrm{BCLK})=16 \mathrm{MHz}, \mathrm{VCC}=2.7 \text { to } 3.6 \mathrm{~V}) \\ & \mathrm{f}(\mathrm{BCLK})=8 \mathrm{MHz}(\mathrm{VCCC}=2.2 \text { to } 3.6 \mathrm{~V}) \\ & \mathrm{f}(\mathrm{BCLK})=4 \mathrm{MHz}, \mathrm{VCC}=1.8 \text { to } 3.6 \mathrm{~V}) \\ & \text { Note: } \mathrm{f}(\mathrm{XIN})=\text { fixed at } 16 \mathrm{MHz} \\ & \hline \end{aligned}$ |

Table 1.2 Specifications for R8C/3MQ Group (2)

| Item | Function | Specification |
| :---: | :---: | :---: |
| Current Consumption ${ }^{(1)}$ |  | RF = Tx: 18 mA <br> $R F=R x$ (reception in progress): 25 mA <br> $R F=R x$ (reception standby): 24 mA <br> $R F=R x$ (reception standby)/wait mode: 23 mA <br> RF = idle: 4 mA <br> RF = off: 2.5 mA <br> *The above applies when: $\mathrm{f}(\mathrm{XIN})=16 \mathrm{MHz}, \mathrm{f}(\mathrm{BCLK})=4 \mathrm{MHz} \text {, and } \mathrm{VCC}=\mathrm{VCCRF}=1.8 \text { to } 3.6 \mathrm{~V}$ |
|  |  | RF = Tx: 19 mA <br> $R F=R x$ (reception in progress): 26 mA <br> $R F=R x$ (reception standby): 25 mA <br> $R F=R x$ (reception standby)/wait mode: 23 mA <br> RF = idle: 5 mA <br> RF = off: 3.5 mA <br> *The above applies when: $f(\mathrm{XIN})=16 \mathrm{MHz}, \mathrm{f}(\mathrm{BLCK})=8 \mathrm{MHz} \text {, and } \mathrm{VCC}=\mathrm{VCCRF}=2.2 \text { to } 3.6 \mathrm{~V}$ |
|  |  | RF = Tx: 21.5 mA <br> $R F=R x$ (reception in progress): 28.5 mA <br> $R F=R x$ (reception standby): 27.5 mA <br> $R F=R x$ (reception standby)/wait mode: 23 mA <br> $\mathrm{RF}=$ idle: 7.5 mA <br> RF = off: 6 mA <br> *The above applies when: $f(\mathrm{XIN})=16 \mathrm{MHz}, \mathrm{f}(\mathrm{BLCK})=16 \mathrm{MHz} \text {, and } \mathrm{VCC}=\mathrm{VCCRF}=2.7 \text { to } 3.6 \mathrm{~V}$ |
|  |  | ```Low-speed on-chip oscillator mode (f(BCLK) \(=15.6 \mathrm{kHz}\) ): \(80 \mu \mathrm{~A}\) Low-speed clock mode ( \(f(B C L K)=32 \mathrm{kHz}\), flash memory low-power- consumption mode): \(95 \mu \mathrm{~A}\) Low-speed clock mode (f(BCLK) \(=32 \mathrm{kHz}\), flash memory off/program operation on RAM: \(45 \mu \mathrm{~A}\) Wait mode (system clock \(=\) XCIN \((32 \mathrm{kHz})\) ), peripheral function clock on: \(6 \mu \mathrm{~A}\) Wait mode (system clock \(=\) XCIN \((32 \mathrm{kHz})\) ), peripheral function clock off: \(4.5 \mu \mathrm{~A}\) Wait mode (system clock \(=\) fOCO-S \((125 \mathrm{kHz})\) ), peripheral function clock on: \(13 \mu \mathrm{~A}\) Wait mode (system clock \(=\) fOCO-S \((125 \mathrm{kHz})\) ), peripheral function clock off: \(7.5 \mu \mathrm{~A}\) Stop mode (all clocks off): \(2 \mu \mathrm{~A}\) *When VCC \(=\) VCCRF \(=1.8\) to 3.6 V and \(\mathrm{RF}=\) off``` |
| Operating Ambient Temperature |  | $-20^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ ( N version) |
| Package |  | 40-pin HWQFN <br> Package code: PWQN0040KB-A (previous code: 40PJS-A) |

Note:

1. Refer to 5. Electrical Characteristics for details on the measurement conditions.

### 1.2 Product List

Table 1.3 lists Product List for R8C/3MQ Group. Figure 1.1 shows a Part Number, Memory Size, and Package of R8C/3MQ Group.

Table 1.3 Product List for R8C/3MQ Group
Current of Aug 2011

| Part No. | ROM Capacity |  | RAM <br> Capacity | Package Type | Remarks |
| :--- | :--- | :--- | :--- | :--- | :--- |
|  | Program ROM | Data flash |  |  |  |
| R5F213M6QNNP | 32 Kbytes | 1 Kbyte $\times 4$ | 2.5 Kbytes | PWQN0040KB-A | N version |
| R5F213M7QNNP | 48 Kbytes | 1 Kbyte $\times 4$ | 4 Kbytes |  |  |
| R5F213M8QNNP | 64 Kbytes | 1 Kbyte $\times 4$ | 6 Kbytes |  |  |
| R5F213MAQNNP | 96 Kbytes | 1 Kbyte $\times 4$ | 7 Kbytes |  |  |
| R5F213MCQNNP | 128 Kbytes | 1 Kbyte $\times 4$ | 7.5 Kbytes |  |  |



Figure 1.1 Part Number, Memory Size, and Package of R8C/3MQ Group

### 1.3 Block Diagram

Figure 1.2 shows a Block Diagram.


Figure 1.2 Block Diagram

### 1.4 Pin Assignment

Figure 1.3 shows Pin Assignment (Top View). Table 1.4 outlines Pin Name Information by Pin Number.


Figure 1.3 Pin Assignment (Top View)

Table 1.4 Pin Name Information by Pin Number

| Pin Number | Control Pin | Port | I/O Pin Functions for Peripheral Modules |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Interrupt | Timer | Serial Interface | SSU | $\mathrm{I}^{2} \mathrm{C}$ bus | RF Pin Other |
| 1 | VREGOUT3 |  |  |  |  |  |  |  |
| 2 | VSS2 |  |  |  |  |  |  |  |
| 3 | XIN |  |  |  |  |  |  |  |
| 4 | XOUT |  |  |  |  |  |  |  |
| 5 | RESET |  |  |  |  |  |  |  |
| 6 | VSS1 |  |  |  |  |  |  |  |
| 7 | MODE |  |  |  |  |  |  |  |
| 8 | VCC |  |  |  |  |  |  |  |
| 9 | (XCIN) | P4_3 |  |  |  |  |  |  |
| 10 | (XCOUT) | P4_4 |  |  |  |  |  |  |
| 11 |  | P1_7 | $\overline{\mathrm{KI} 7 / / \overline{\mathrm{INT}}}$ | (TRAIO) |  |  |  |  |
| 12 |  | P1_6 | $\overline{\mathrm{KI}} 6$ |  | (CLK0) |  |  |  |
| 13 |  | P1_5 | $\overline{\mathrm{KIF}}$ (/INT1) | (TRAIO) | (RXD0) |  |  |  |
| 14 |  | P1_4 | $\overline{\mathrm{KI} 4}$ | (TRCCLK) | (TXD0) |  |  |  |
| 15 |  | P1_3 | $\overline{\mathrm{K} 13}$ | TRBO(/TRCIOC) |  |  |  |  |
| 16 |  | P1_2 | $\overline{\mathrm{KI} 2}$ | (TRCIOB) |  |  |  |  |
| 17 |  | P1_1 | $\overline{\mathrm{K} 11}$ | (TRCIOA/TRCTRG) |  |  |  |  |
| 18 |  | P1_0 | $\overline{\mathrm{KIO}}$ | (TRCIOD) |  |  |  |  |
| 19 |  |  |  |  |  |  |  | IFRXTP |
| 20 |  |  |  |  |  |  |  | IFRXTN |
| 21 | VCCRF |  |  |  |  |  |  |  |
| 22 | VREGOUT1 |  |  |  |  |  |  |  |
| 23 | VREG1 |  |  |  |  |  |  |  |
| 24 | VREG2 |  |  |  |  |  |  |  |
| 25 | VSSRF |  |  |  |  |  |  |  |
| 26 |  |  |  |  |  |  |  | RFIOP |
| 27 |  |  |  |  |  |  |  | RFION |
| 28 | VSSRF1 |  |  |  |  |  |  |  |
| 29 | VSSRF2 |  |  |  |  |  |  |  |
| 30 | VREG3 |  |  |  |  |  |  |  |
| 31 | VREGOUT2 |  |  |  |  |  |  |  |
| 32 | VREG4 |  |  |  |  |  |  |  |
| 33 |  | P0_4 |  | TREO(/TRCIOB) |  |  |  | ASW |
| 34 |  | P3_7 |  | TRAO |  | SSO | SDA |  |
| 35 |  | P3_5 |  | (TRCIOD) |  | SSCK | SCL |  |
| 36 |  | P3_4 |  | (TRCIOC) |  | SSI |  |  |
| 37 |  | P3_3 | $\overline{\text { INT3 }}$ | (TRCCLK) |  | $\overline{\text { SCS }}$ |  |  |
| 38 |  | P3_1 |  | (TRBO) |  |  |  |  |
| 39 |  | P3_0 |  | (TRAO) |  |  |  |  |
| 40 |  | P4_5 | $\overline{\text { INTO }}$ |  |  |  |  |  |
| Bottom side | DIEGND |  |  |  |  |  |  |  |

Note:

1. The function in parentheses can be assigned to the pin by a program.

### 1.5 Pin Functions

Tables 1.5 and 1.6 list Pin Functions.
Table 1.5 Pin Functions (1)

| Item | Pin Name | I/O Type | Description |
| :---: | :---: | :---: | :---: |
| Power supply input | VCC, VSS1 | - | Apply 1.8 to 3.6 V to the VCC pin. Apply 0 V to the VSS1 pin. |
| Reset input | $\overline{\text { RESET }}$ | 1 | Input "L" on this pin resets the MCU. |
| MODE | MODE | I | Connect this pin to VCC via a resistor. |
| XIN clock input | XIN | I | These pins are provided for XIN clock oscillation circuit I/O. Connect a crystal oscillator between the XIN and XOUT pins. |
| XIN clock output | XOUT | I/O |  |
| XCIN clock input | XCIN | 1 | These pins are provided for XCIN clock oscillation circuit I/O. Connect a crystal oscillator between the XCIN and XCOUT pins. |
| XCIN clock output | XCOUT | 0 |  |
| $\overline{\text { INT }}$ interrupt input | $\overline{\mathrm{INTO}}, \overline{\mathrm{INT} 1}, \overline{\mathrm{INT3}}$ | I | INT interrupt input pins. $\overline{\mathrm{INTO}}$ is used as an input pin for timer RB and timer RC. |
| Key input interrupt input | $\overline{\mathrm{KIO}}$ to $\overline{\mathrm{KI} 7}$ | I | Key input interrupt input pins. |
| Timer RA | TRAIO | I/O | Timer RA I/O pin. |
|  | TRAO | 0 | Timer RA output pin. |
| Timer RB | TRBO | 0 | Timer RB output pin. |
| Timer RC | TRCCLK | I | External clock input pin. |
|  | TRCTRG | 1 | External trigger input pin. |
|  | TRCIOA, TRCIOB, TRCIOC, TRCIOD | I/O | Timer RC I/O pins. |
| Timer RE | TREO | 0 | Divided clock output pin. |
| Serial interface | CLK0 | I/O | Transfer clock I/O pin. |
|  | RXD0 | I | Serial data input pin. |
|  | TXD0 | 0 | Serial data output pin. |
| SSU | SSI | I/O | Data I/O pin. |
|  | $\overline{\text { SCS }}$ | I/O | Chip-select signal I/O pin. |
|  | SSCK | I/O | Clock I/O pin. |
|  | SSO | I/O | Data I/O pin. |
| ${ }^{2} \mathrm{C}$ bus | SCL | I/O | Clock I/O pin |
|  | SDA | I/O | Data I/O pin |
| I/O ports | $\begin{aligned} & \text { P0_4, P1_0 to P1_7, } \\ & \text { P3_0, P3_1, } \\ & \text { P3_3 to P3_5, P3_7, } \\ & \text { P4_3 to P4_5 } \end{aligned}$ | I/O | CMOS I/O ports. Each port has an I/O select direction register, allowing each pin in the port to be directed for input or output individually. <br> Any port set to input can be set to use a pull-up resistor or not by a program. |

I: Input O: Output I/O: Input and output

Table 1.6 Pin Functions (2)

| Item | Pin Name | I/O Type | Description |
| :--- | :--- | :---: | :--- |
| Analog power <br> supply input | VCCRF, VSSRF, <br> VSSRF1, VSSRF2, <br> VSS2, DIEGND | - | Apply the same voltage as the VCC of 1.8 V to 3.6 V to <br> VCCRF. Apply 0 V to VSSRF, VSSRF1, VSSRF2, VSS2, <br> and DIEGND. |
|  | VREG1 | - | 1.5 V IF VDD pin. Connect to the VREGOUT1 pin. |
|  | VREG2 | - | 1.5 V LNA/MIX/PA VDD pin. Connect to the VREGOUT1 pin. |
|  | VREG3 | - | 1.5 V PLL ANALOG VDD pin. Connect to the VREGOUT1 <br> pin. |
|  | VREG4 | - | 1.5 V PLL DIGITAL VDD pin. Connect to the VREGOUT1 <br> pin. |
|  | VREGOUT1 | - | On-chip regulator output (1.5 V) pin for the analog circuit. <br> Connect only a bypass capacitor between pins VREGOUT1 <br> and VSS. <br> Use only as the power supply for pins VREG1, VREG2, <br> VREG3, and VREGF4. |
|  | VREGOUT2 | - | Regulator output (1.5 V) pin for the VCO circuit. <br> Connect only a bypass capacitor between pins VREGOUT2 <br> and VSS. <br> Do not use as the power supply for other circuits. |
|  | VREGOUT3 | - | Regulator output (1.5 V) pin for the XIN oscillation circuit. <br> Connect only a bypass capacitor between pins VREGOUT3 <br> and VSS. <br> Do not use as the power supply for other circuits. |
| RF I/O | RFIOP, RFION | I/O | RF I/O pins |
| Test pins | IFRXTN, IFRXTP | I/O | Ports for testing. Leave open or apply 0 V. |
| External antenna <br> switch control <br> output | ASW | Signal output pin to control the external antenna switch. <br> If antenna switch control is not required, leave open. |  |

I: Input O: Output I/O: Input and output

## 2. Central Processing Unit (CPU)

Figure 2.1 shows the CPU Registers. The CPU contains 13 registers. R0, R1, R2, R3, A0, A1, and FB configure a register bank. There are two sets of register bank.



| b19 | b15 |
| :--- | :--- | Interrupt table register

The 4 high order bits of INTB are INTBH and the 16 low order bits of INTB are INTBL.


Note:

1. These registers comprise a register bank. There are two register banks.

Figure 2.1 CPU Registers

### 2.1 Data Registers (R0, R1, R2, and R3)

R0 is a 16-bit register for transfer, arithmetic, and logic operations. The same applies to R1 to R3. R0 can be split into high-order bits $(\mathrm{R} 0 \mathrm{H})$ and low-order bits ( R 0 L ) to be used separately as 8 -bit data registers. R1H and R1L are analogous to R0H and R0L. R2 can be combined with R0 and used as a 32-bit data register (R2R0). R3R1 is analogous to R2R0.

### 2.2 Address Registers (A0 and A1)

A0 is a 16-bit register for address register indirect addressing and address register relative addressing. It is also used for transfer, arithmetic, and logic operations. A1 is analogous to A0. A1 can be combined with A0 and as a 32bit address register (A1A0).

### 2.3 Frame Base Register (FB)

FB is a 16 -bit register for FB relative addressing.

### 2.4 Interrupt Table Register (INTB)

INTB is a 20-bit register that indicates the starting address of a relocatable interrupt vector table.

### 2.5 Program Counter (PC)

PC is 20 bits wide and indicates the address of the next instruction to be executed.

### 2.6 User Stack Pointer (USP) and Interrupt Stack Pointer (ISP)

The stack pointers (SP), USP and ISP, are each 16 bits wide. The $U$ flag of FLG is used to switch between USP and ISP.

### 2.7 Static Base Register (SB)

SB is a 16 -bit register for SB relative addressing.

### 2.8 Flag Register (FLG)

FLG is an 11-bit register indicating the CPU state.

### 2.8.1 Carry Flag (C)

The C flag retains carry, borrow, or shift-out bits that have been generated by the arithmetic and logic unit.

### 2.8.2 Debug Flag (D)

The D flag is for debugging only. Set it to 0 .

### 2.8.3 Zero Flag (Z)

The Z flag is set to 1 when an arithmetic operation results in 0 ; otherwise to 0 .

### 2.8.4 Sign Flag (S)

The S flag is set to 1 when an arithmetic operation results in a negative value; otherwise to 0 .

### 2.8.5 Register Bank Select Flag (B)

Register bank 0 is selected when the $B$ flag is 0 . Register bank 1 is selected when this flag is set to 1 .

### 2.8.6 Overflow Flag (O)

The O flag is set to 1 when an operation results in an overflow; otherwise to 0 .

### 2.8.7 Interrupt Enable Flag (I)

The I flag enables maskable interrupts.
Interrupts are disabled when the I flag is set to 0 , and are enabled when the I flag is set to 1 . The I flag is set to 0 when an interrupt request is acknowledged.

### 2.8.8 Stack Pointer Select Flag (U)

ISP is selected when the U flag is set to 0 ; USP is selected when the U flag is set to 1 .
The U flag is set to 0 when a hardware interrupt request is acknowledged or the INT instruction of software interrupt numbers 0 to 31 is executed.

### 2.8.9 Processor Interrupt Priority Level (IPL)

IPL is 3 bits wide and assigns processor interrupt priority levels from level 0 to level 7.
If a requested interrupt has higher priority than IPL, the interrupt is enabled.

### 2.8.10 Reserved Bit

If necessary, set to 0 . When read, the content is undefined.

## 3. Memory

### 3.1 R8C/3MQ Group

Figure 3.1 is a Memory Map of R8C/3MQ Group. The R8C/3MQ Group has a 1-Mbyte address space from addresses 00000 h to FFFFFh. The internal ROM (program ROM) is allocated lower addresses, beginning with address 0FFFFh. However, for products with internal ROM (program ROM) capacity of 64 Kbytes or more, the internal ROM is also allocated higher addresses, beginning with address 0FFFFh.
For example, a 32 -Kbyte internal ROM area is allocated addresses 08000 h to 0 FFFFh, and a $96-\mathrm{Kbyte}$ internal ROM is allocated addresses 04000 h to 1 BFFFh .
The fixed interrupt vector table is allocated addresses 08000h to 0FFFFh. The starting address of each interrupt routine is stored here.
The internal ROM (data flash) is allocated addresses 03000h to 03FFFh.
The internal RAM is allocated higher addresses, beginning with address 00400 h . For example, a 2.5 -Kbyte internal RAM area is allocated addresses 00400 h to 00DFFh. The internal RAM is used not only for data storage but also as a stack area when a subroutine is called or when an interrupt request is acknowledged.
Special function registers (SFRs) are allocated addresses 00000h to 002FFh and 02C00h to 02FFFh. Peripheral function control registers are allocated here. All unallocated spaces within the SFRs are reserved and cannot be accessed by users.


Figure 3.1 Memory Map of R8C/3MQ Group

## 4. Special Function Registers (SFRs)

An SFR (special function register) is a control register for a peripheral function. Tables 4.1 to 4.11 list the special function registers. Table 4.12 lists the ID Code Areas and Option Function Select Area.

Table 4.1 SFR Information (1) (0000h to 002Fh) (1)

| Address | Register | Symbol | After Reset |
| :---: | :---: | :---: | :---: |
| 0000h |  |  |  |
| 0001h |  |  |  |
| 0002h |  |  |  |
| 0003h |  |  |  |
| 0004h | Processor Mode Register 0 | PM0 | 00h |
| 0005h | Processor Mode Register 1 | PM1 | 00h |
| 0006h | System Clock Control Register 0 | CM0 | 00101000b |
| 0007h | System Clock Control Register 1 | CM1 | 00101000b |
| 0008h | Module Standby Control Register | MSTCR | 00h |
| 0009h | System Clock Control Register 3 | CM3 | 00h |
| 000Ah | Protect Register | PRCR | 00h |
| 000Bh | Reset Source Determination Register | RSTFR | 0XXXXXXXb ${ }^{(2)}$ |
| 000Ch | Oscillation Stop Detection Register | OCD | 00000100b |
| 000Dh | Watchdog Timer Reset Register | WDTR | XXh |
| 000Eh | Watchdog Timer Start Register | WDTS | XXh |
| 000Fh | Watchdog Timer Control Register | WDTC | 00111111b |
| 0010h |  |  |  |
| 0011h |  |  |  |
| 0012h |  |  |  |
| 0013h |  |  |  |
| 0014h |  |  |  |
| 0015h |  |  |  |
| 0016h |  |  |  |
| 0017h |  |  |  |
| 0018h |  |  |  |
| 0019h |  |  |  |
| 001Ah |  |  |  |
| 001Bh |  |  |  |
| 001Ch | Count Source Protection Mode Register | CSPR | $\begin{aligned} & \hline 00 \mathrm{~h} \\ & 10000000 \mathrm{~b} \end{aligned}$ |
| 001Dh |  |  |  |
| 001Eh |  |  |  |
| 001Fh |  |  |  |
| 0020h |  |  |  |
| 0021h |  |  |  |
| 0022h |  |  |  |
| 0023h |  |  |  |
| 0024h |  |  |  |
| 0025h |  |  |  |
| 0026h |  |  |  |
| 0027h |  |  |  |
| 0028h | Clock Prescaler Reset Flag | CPSRF | 00h |
| 0029h |  |  |  |
| 002Ah |  |  |  |
| 002Bh |  |  |  |
| 002Ch |  |  |  |
| 002Dh |  |  |  |
| 002Eh |  |  |  |
| 002Fh |  |  |  |

X : Undefined
Notes:

1. The blank areas are reserved and cannot be accessed by users.
2. The CWR bit in the RSTFR register is set to 0 after power-on and voltage monitor 0 reset. Hardware reset, software reset, or watchdog timer reset does not affect this bit.
3. The CSPROINI bit in the OFS register is set to 0 .

Table 4.2 SFR Information (2) (0030h to 006Fh) (1)

| Address | Register | Symbol | After Reset |
| :---: | :---: | :---: | :---: |
| 0030h | Voltage Monitor Circuit Control Register | CMPA | 00h |
| 0031h | Voltage Monitor Circuit Edge Select Register | VCAC | 00h |
| 0032h |  |  |  |
| 0033h |  |  |  |
| 0034h | Voltage detection Register 2 | VCA2 | $\begin{aligned} & \hline 00 h^{(3)} \\ & 00100000 \mathrm{~b} \text { (4) } \end{aligned}$ |
| 0035h |  |  |  |
| 0036h | Voltage Detection 1 Level Select Register | VD1LS | 00000111b |
| 0037h |  |  |  |
| 0038h | Voltage Monitor 0 Circuit Control Register | VW0C | $\begin{aligned} & \hline 1100 \times 010 \mathrm{~b} \\ & 1100 \times 011 \mathrm{~b} \\ & \text { (4) } \end{aligned}$ |
| 0039h | Voltage Monitor 1 Circuit Control Register | VW1C | 10001010b |
| 003Ah | WDT Detection Flag | VW2C | 10000010b |
| 003Bh |  |  |  |
| 003Ch |  |  |  |
| 003Dh |  |  |  |
| 003Eh |  |  |  |
| 003Fh |  |  |  |
| 0040h |  |  |  |
| 0041h | Flash Memory Ready Interrupt Control Register | FMRDYIC | XXXXX000b |
| 0042h | BB Timer Compare 2 Interrupt Control Register | BBTIM2IC | XXXXX000b |
| 0043h |  |  |  |
| 0044h |  |  |  |
| 0045h |  |  |  |
| 0046h |  |  |  |
| 0047h | Timer RC Interrupt Control Register | TRCIC | XXXXX000b |
| 0048h |  |  |  |
| 0049h |  |  |  |
| 004Ah | Timer RE Interrupt Control Register | TREIC | XXXXX000b |
| 004Bh |  |  |  |
| 004Ch |  |  |  |
| 004Dh | Key Input Interrupt Control Register | KUPIC | XXXXX000b |
| 004Eh |  |  |  |
| 004Fh | SSU Interrupt Control Register/IIC bus Interrupt Control Register (2) | SSUIC/IICIC | XXXXX000b |
| 0050h |  |  |  |
| 0051h | UART0 Transmit Interrupt Control Register | SOTIC | XXXXX000b |
| 0052h | UART0 Receive Interrupt Control Register | SORIC | XXXXX000b |
| 0053h |  |  |  |
| 0054h | Bank 0 Reception Complete/IDLE Interrupt Control Register (5) | BBRXOIC/BBIDELIC | XXXXX000b |
| 0055h |  |  |  |
| 0056h | Timer RA Interrupt Control Register | TRAIC | XXXXX000b |
| 0057h |  |  |  |
| 0058h | Timer RB Interrupt Control Register | TRBIC | XXXXX000b |
| 0059h | INT1 Interrupt Control Register | INT1IC | XX00X000b |
| 005Ah | INT3 Interrupt Control Register | INT3IC | XX00X000b |
| 005Bh |  |  |  |
| 005Ch | BB Timer Compare 1 Interrupt Control Register | BBTIM1IC | XX00X000b |
| 005Dh | INTO Interrupt Control Register | INTOIC | XX00X000b |
| 005Eh | CCA Complete Interrupt Control Register | BBCCAIC | XXXXX000b |
| 005Fh | BB Timer Compare 0 Interrupt Control Register | BBTIMOIC | XXXXX000b |
| 0060h |  |  |  |
| 0061h |  |  |  |
| 0062h |  |  |  |
| 0063h |  |  |  |
| 0064h |  |  |  |
| 0065h |  |  |  |
| 0066h |  |  |  |
| 0067h |  |  |  |
| 0068h |  |  |  |
| 0069h |  |  |  |
| 006Ah |  |  |  |
| 006Bh |  |  |  |
| 006Ch | Address Filter Interrupt Control Register | BBADFIC | XXXXX000b |
| 006Dh | Transmit Overrun Interrupt Control Register | BBTXORIC | XXXXX000b |
| 006Eh | Transmission Complete Interrupt Control Register | BBTXIC | XX00XX00b |
| 006Fh | Receive Overrun 1 Interrupt Control Register | BBRXOR1IC | XXXXX000b |

X: Undefined
Notes:

1. The blank areas are reserved and cannot be accessed by users.
2. Selectable by the IICSEL bit in the SSUIICSR register.
3. The LVDAS bit in the OFS register is set to 1 .
4. The LVDAS bit in the OFS register is set to 0 .
5. Can be selected by the BANKOINTSEL bit in the BBTXRXMODE4 register.

Table 4.3 SFR Information (3) (0070h to 00AFh) (1)

| Address | Register | Symbol | After Reset |
| :---: | :---: | :---: | :---: |
| 0070h | PLL Lock Detection Interrupt Control Register | BBPLLIC | XXXXX000b |
| 0071h | Receive Overrun 0/Calibration Complete Interrupt Control Register (3) | BBRXOROIC/BBCALIC | XXXXX000b |
| 0072h | Voltage Monitor 1 Interrupt Control Register | VCMP1IC | XXXXX000b |
| 0073h | Bank 1 Reception Complete/Clock Regulator Interrupt Control Register (2) | BBRX1IC/BBCREGIC | XXXXX000b |
| 0074h |  |  |  |
| 0075h |  |  |  |
| 0076h |  |  |  |
| 0077h |  |  |  |
| 0078h |  |  |  |
| 0079h |  |  |  |
| 007Ah |  |  |  |
| 007Bh |  |  |  |
| 007Ch |  |  |  |
| 007Dh |  |  |  |
| 007Eh |  |  |  |
| 007Fh |  |  |  |
| 0080h | DTC Activation Control Register | DTCTL | 00h |
| 0081h |  |  |  |
| 0082h |  |  |  |
| 0083h |  |  |  |
| 0084h |  |  |  |
| 0085h |  |  |  |
| 0086h |  |  |  |
| 0087h |  |  |  |
| 0088h | DTC Activation Enable Register 0 | DTCEN0 | 00h |
| 0089h | DTC Activation Enable Register 1 | DTCEN1 | 00h |
| 008Ah | DTC Activation Enable Register 2 | DTCEN2 | 00h |
| 008Bh | DTC Activation Enable Register 3 | DTCEN3 | 00h |
| 008Ch |  |  |  |
| 008Dh | DTC Activation Enable Register 5 | DTCEN5 | 00h |
| 008Eh | DTC Activation Enable Register 6 | DTCEN6 | 00h |
| 008Fh |  |  |  |
| 0090h |  |  |  |
| 0091h |  |  |  |
| 0092h |  |  |  |
| 0093h |  |  |  |
| 0094h |  |  |  |
| 0095h |  |  |  |
| 0096h |  |  |  |
| 0097h |  |  |  |
| 0098h |  |  |  |
| 0099h |  |  |  |
| 009Ah |  |  |  |
| 009Bh |  |  |  |
| 009Ch |  |  |  |
| 009Dh |  |  |  |
| 009Eh |  |  |  |
| 009Fh |  |  |  |
| 00AOh | UART0 Transmit/Receive Mode Register | UOMR | 00h |
| 00A1h | UART0 Bit Rate Register | U0BRG | XXh |
| 00A2h | UART0 Transmit Buffer Register | U0TB | XXh |
| 00A3h |  |  | XXh |
| 00A4h | UART0 Transmit/Receive Control Register 0 | U0C0 | 00001000b |
| 00A5h | UART0 Transmit/Receive Control Register 1 | U0C1 | 00000010b |
| 00A6h | UART0 Receive Buffer Register | U0RB | XXh |
| 00A7h |  |  | XXh |
| 00A8h |  |  |  |
| 00A9h |  |  |  |
| 00AAh |  |  |  |
| 00ABh |  |  |  |
| 00ACh |  |  |  |
| 00ADh |  |  |  |
| 00AEh |  |  |  |
| 00AFh |  |  |  |

X: Undefined
Notes:

1. The blank areas are reserved and cannot be accessed by users.
2. Can be selected by the BANK1INTSEL bit in the BBTXRXMODE4 register
3. Can be selected by the ROROINTSEL bit in the BBTXRXMODE4 register.

Table 4.4 SFR Information (4) (00BOh to 011Fh) ${ }^{(1)}$

| Address | Register | Symbol | After Reset |
| :---: | :---: | :---: | :---: |
| 00BOh |  |  |  |


| 00DFh |  |  |  |
| :---: | :---: | :---: | :---: |
| 00DFh |  |  |  |
| 00EOh | Port P0 Register | P0 | XXh |
| 00E1h | Port P1 Register | P1 | XXh |
| 00E2h | Port P0 Direction Register | PD0 | 00h |
| 00E3h | Port P1 Direction Register | PD1 | 00h |
| 00E4h |  |  |  |
| 00E5h | Port P3 Register | P3 | XXh |
| 00E6h |  |  |  |
| 00E7h | Port P3 Direction Register | PD3 | 00h |
| 00E8h | Port P4 Register | P4 | XXh |
| 00E9h |  |  |  |
| 00EAh | Port P4 Direction Register | PD4 | 00h |
| 00EBh |  |  |  |
| 00ECh |  |  |  |
| 00EDh |  |  |  |
| 00EEh |  |  |  |
| 00EFh |  |  |  |
| 00FOh |  |  |  |
| 00F1h |  |  |  |
| 00F2h |  |  |  |
| 00F3h |  |  |  |
| 00F4h |  |  |  |
| 00F5h |  |  |  |
| 00F6h |  |  |  |
| 00F7h |  |  |  |
| 00F8h |  |  |  |
| 00F9h |  |  |  |
| 00FAh |  |  |  |
| 00FBh |  |  |  |
| 00FCh |  |  |  |
| 00FDh |  |  |  |
| 00FEh |  |  |  |
| 00FFh |  |  |  |
| 0100h | Timer RA Control Register | TRACR | 00h |
| 0101h | Timer RA I/O Control Register | TRAIOC | 00h |
| 0102h | Timer RA Mode Register | TRAMR | 00h |
| 0103h | Timer RA Prescaler Register | TRAPRE | FFh |
| 0104h | Timer RA Register | TRA | FFh |
| 0105h |  |  |  |
| 0106h |  |  |  |
| 0107h |  |  |  |
| 0108h | Timer RB Control Register | TRBCR | 00h |
| 0109h | Timer RB One-Shot Control Register | TRBOCR | 00h |
| 010Ah | Timer RB I/O Control Register | TRBIOC | 00h |
| 010Bh | Timer RB Mode Register | TRBMR | 00h |
| 010Ch | Timer RB Prescaler Register | TRBPRE | FFh |
| 010Dh | Timer RB Secondary Register | TRBSC | FFh |
| 010Eh | Timer RB Primary Register | TRBPR | FFh |
| 010Fh |  |  |  |
| 0110h |  |  |  |
| 0111h |  |  |  |
| 0112h |  |  |  |
| 0113h |  |  |  |
| 0114h |  |  |  |
| 0115h |  |  |  |
| 0116h |  |  |  |
| 0117h |  |  |  |
| 0118h | Timer RE Second Data Register / Counter Data Register | TRESEC | 00h |
| 0119h | Timer RE Minute Data Register / Compare Data Register | TREMIN | 00h |
| 011Ah | Timer RE Hour Data Register | TREHR | 00h |
| 011Bh | Timer RE Day of Week Data Register | TREWK | 00h |
| 011Ch | Timer RE Control Register 1 | TRECR1 | 00h |
| 011Dh | Timer RE Control Register 2 | TRECR2 | 00h |
| 011Eh | Timer RE Count Source Select Register | TRECSR | 00001000b |
| 011Fh |  |  |  |

X: Undefined
Note:

1. The blank areas are reserved and cannot be accessed by users.

Table 4.5 SFR Information (5) (0120h to 019Fh) (1)

| Address | Register | Symbol | After Reset |
| :---: | :---: | :---: | :---: |
| 0120h | Timer RC Mode Register | TRCMR | 01001000b |
| 0121h | Timer RC Control Register 1 | TRCCR1 | 00h |
| 0122h | Timer RC Interrupt Enable Register | TRCIER | 01110000b |
| 0123h | Timer RC Status Register | TRCSR | 01110000b |
| 0124h | Timer RC I/O Control Register 0 | TRCIOR0 | 10001000b |
| 0125h | Timer RC I/O Control Register 1 | TRCIOR1 | 10001000b |
| 0126h | Timer RC Counter | TRC | 00h |
| 0127h |  |  | 00h |
| 0128h | Timer RC General Register A | TRCGRA | FFh |
| 0129h |  |  | FFh |
| 012Ah | Timer RC General Register B | TRCGRB | FFh |
| 012Bh |  |  | FFh |
| 012Ch | Timer RC General Register C | TRCGRC | FFh |
| 012Dh |  |  | FFh |
| 012Eh | Timer RC General Register D | TRCGRD | FFh |
| 012Fh |  |  | FFh |
| 0130h | Timer RC Control Register 2 | TRCCR2 | 00011000b |
| 0131h | Timer RC Digital Filter Function Select Register | TRCDF | 00h |
| 0132h | Timer RC Output Master Enable Register | TRCOER | 01111111b |
| 0133h |  |  |  |
| 0134h |  |  |  |
| 0135h |  |  |  |
| 0136h |  |  |  |
| 0137h |  |  |  |
| 0138h |  |  |  |
| 0139h |  |  |  |
| 013Ah |  |  |  |
| 013Bh |  |  |  |
| 013Ch |  |  |  |
| 013Dh |  |  |  |
| 013Eh |  |  |  |
| 013Fh |  |  |  |


| 0180h | Timer RA Pin Select Register | TRASR | 00h |
| :---: | :---: | :---: | :---: |
| 0181h | Timer RB/RC Pin Select Register | TRBRCSR | 00h |
| 0182h | Timer RC Pin Select Register 0 | TRCPSR0 | 00h |
| 0183h | Timer RC Pin Select Register 1 | TRCPSR1 | 00h |
| 0184h |  |  |  |
| 0185h |  |  |  |
| 0186h |  |  |  |
| 0187h |  |  |  |
| 0188h | UART0 Pin Select Register | U0SR | 00h |
| 0189h |  |  |  |
| 018Ah |  |  |  |
| 018Bh |  |  |  |
| 018Ch | SSU/IIC Pin Select Register | SSUIICSR | 00h |
| 018Dh |  |  |  |
| 018Eh | INT Interrupt Input Pin Select Register | INTSR | 00h |
| 018Fh | I/O Function Pin Select Register | PINSR | 00h |
| 0190h |  |  |  |
| 0191h |  |  |  |
| 0192h |  |  |  |
| 0193h | SS Bit Counter Register | SSBR | 11111000b |
| 0194h | SS Transmit Data Register L / IIC bus Transmit Data Register (2) | SSTDR / ICDRT | FFh |
| 0195h | SS Transmit Data Register H ${ }^{(2)}$ | SSTDRH | FFh |
| 0196h | SS Receive Data Register L / IIC bus Receive Data Register (2) | SSRDR / ICDRR | FFh |
| 0197h | SS Receive Data Register H ${ }^{(2)}$ | SSRDRH | FFh |
| 0198h | SS Control Register H / IIC bus Control Register 1 (2) | SSCRH / ICCR1 | 00h |
| 0199h | SS Control Register L / IIC bus Control Register 2 (2) | SSCRL / ICCR2 | 01111101b |
| 019Ah | SS Mode Register / IIC bus Mode Register (2) | SSMR / ICMR | 00011000b |
| 019Bh | SS Enable Register / IIC bus Interrupt Enable Register (2) | SSER / ICIER | 00h |
| 019Ch | SS Status Register / IIC bus Status Register (2) | SSSR / ICSR | 00h / 0000X000b |
| 019Dh | SS Mode Register 2 / Slave Address Register (2) | SSMR2 / SAR | 00h |
| 019Eh |  |  |  |
| 019Fh |  |  |  |

X: Undefined
Note:

1. The blank areas are reserved and cannot be accessed by users.
2. Selectable by the IICSEL bit in the SSUIICSR register.

Table 4.6 SFR Information (6) (01AOh to 02FFh) (1)

| Address | Register | Symbol | After Reset |
| :---: | :---: | :---: | :---: |
| 01 AOh |  |  |  |


| 01B0h |  |  |  |
| :---: | :---: | :---: | :---: |
| 01B1h |  |  |  |
| 01B2h | Flash Memory Status Register | FST | 10000X00b |
| 01B3h |  |  |  |
| 01B4h | Flash Memory Control Register 0 | FMR0 | 00h |
| 01B5h | Flash Memory Control Register 1 | FMR1 | 00h |
| 01B6h | Flash Memory Control Register 2 | FMR2 | 00h |
| 01B7h |  |  |  |
| 01B8h |  |  |  |
| 01B9h |  |  |  |
| 01BAh |  |  |  |
| 01BBh |  |  |  |
| 01BCh |  |  |  |
| 01BDh |  |  |  |
| 01BEh |  |  |  |
| 01BFh |  |  |  |
| 01C0h | Address Match Interrupt Register 0 | RMAD0 | XXh |
| 01C1h |  |  | XXh |
| 01C2h |  |  | 0000XXXXb |
| 01C3h | Address Match Interrupt Enable Register 0 | AIER0 | 00h |
| 01C4h | Address Match Interrupt Register 1 | RMAD1 | XXh |
| 01C5h |  |  | XXh |
| 01C6h |  |  | 0000XXXXb |
| 01C7h | Address Match Interrupt Enable Register 1 | AIER1 | 00h |
| 01C8h |  |  |  |


| 01DFh |  |  |  |
| :---: | :---: | :---: | :---: |
| 01E0h | Pull-Up Control Register 0 | PUR0 | 00h |
| 01E1h | Pull-Up Control Register 1 | PUR1 | 00h |
| 01E2h |  |  |  |
| 01E3h |  |  |  |
| 01E4h |  |  |  |
| 01E5h |  |  |  |
| 01E6h |  |  |  |
| 01E7h |  |  |  |
| 01E8h |  |  |  |
| 01E9h |  |  |  |
| 01EAh |  |  |  |
| 01EBh |  |  |  |
| 01ECh |  |  |  |
| 01EDh |  |  |  |
| 01EEh |  |  |  |
| 01EFh |  |  |  |
| 01F0h | Port P1 Drive Capacity Control Register | P1DRR | 00h |
| 01F1h |  |  |  |
| 01F2h | Drive Capacity Control Register 0 | DRR0 | 00h |
| 01F3h | Drive Capacity Control Register 1 | DRR1 | 00h |
| 01F4h |  |  |  |
| 01F5h | Input Threshold Control Register 0 | VLT0 | 00h |
| 01F6h | Input Threshold Control Register 1 | VLT1 | 00h |
| 01F7h |  |  |  |
| 01F8h |  |  |  |
| 01F9h |  |  |  |
| 01FAh | External Input Enable Register 0 | INTEN | 00h |
| 01FBh |  |  |  |
| 01FCh | INT Input Filter Select Register 0 | INTF | 00h |
| 01FDh |  |  |  |
| 01FEh | Key Input Enable Register 0 | KIEN | 00h |
| 01FFh | Key Input Enable Register 1 | KI1EN | 00h |
| 0200h |  |  |  |


| 02FFh |  |  |
| :--- | :--- | :--- | :--- |

X: Undefined
Notes:

1. The blank areas are reserved and cannot be accessed by users.

Table 4.7 SFR Information (7) (2C00h to 2C6Fh) (1)

| Address | Register | Symbol | After Reset |
| :---: | :---: | :---: | :---: |
| 2C00h | DTC Transfer Vector Area |  | XXh |
| 2C01h | DTC Transfer Vector Area |  | XXh |
| 2C02h | DTC Transfer Vector Area |  | XXh |
| 2C03h | DTC Transfer Vector Area |  | XXh |
| 2C04h | DTC Transfer Vector Area |  | XXh |
| 2C05h | DTC Transfer Vector Area |  | XXh |
| 2C06h | DTC Transfer Vector Area |  | XXh |
| 2C07h | DTC Transfer Vector Area |  | XXh |
| 2C08h | DTC Transfer Vector Area |  | XXh |
| 2C09h | DTC Transfer Vector Area |  | XXh |
| 2C0Ah | DTC Transfer Vector Area |  | XXh |
| : | DTC Transfer Vector Area |  | XXh |
| : | DTC Transfer Vector Area |  | XXh |
| 2C3Ah | DTC Transfer Vector Area |  | XXh |
| 2C3Bh | DTC Transfer Vector Area |  | XXh |
| 2C3Ch | DTC Transfer Vector Area |  | XXh |
| 2C3Dh | DTC Transfer Vector Area |  | XXh |
| 2C3Eh | DTC Transfer Vector Area |  | XXh |
| 2C3Fh | DTC Transfer Vector Area |  | XXh |
| 2C40h | DTC Control Data 0 | DTCD0 | XXh |
| 2C41h |  |  | XXh |
| 2C42h |  |  | XXh |
| 2C43h |  |  | XXh |
| 2C44h |  |  | XXh |
| 2C45h |  |  | XXh |
| 2C46h |  |  | XXh |
| 2C47h |  |  | XXh |
| 2C48h | DTC Control Data 1 | DTCD1 | XXh |
| 2C49h |  |  | XXh |
| 2C4Ah |  |  | XXh |
| 2C4Bh |  |  | XXh |
| 2C4Ch |  |  | XXh |
| 2C4Dh |  |  | XXh |
| 2C4Eh |  |  | XXh |
| 2C4Fh |  |  | XXh |
| 2C50h | DTC Control Data 2 | DTCD2 | XXh |
| 2C51h |  |  | XXh |
| 2C52h |  |  | XXh |
| 2C53h |  |  | XXh |
| 2C54h |  |  | XXh |
| 2C55h |  |  | XXh |
| 2C56h |  |  | XXh |
| 2C57h |  |  | XXh |
| 2C58h | DTC Control Data 3 | DTCD3 | XXh |
| 2C59h |  |  | XXh |
| 2C5Ah |  |  | XXh |
| 2C5Bh |  |  | XXh |
| 2C5Ch |  |  | XXh |
| 2C5Dh |  |  | XXh |
| 2C5Eh |  |  | XXh |
| 2C5Fh |  |  | XXh |
| 2C60h | DTC Control Data 4 | DTCD4 | XXh |
| 2C61h |  |  | XXh |
| 2C62h |  |  | XXh |
| 2C63h |  |  | XXh |
| 2C64h |  |  | XXh |
| 2C65h |  |  | XXh |
| 2C66h |  |  | XXh |
| 2C67h |  |  | XXh |
| 2C68h | DTC Control Data 5 | DTCD5 | XXh |
| 2C69h |  |  | XXh |
| 2C6Ah |  |  | XXh |
| 2C6Bh |  |  | XXh |
| 2C6Ch |  |  | XXh |
| 2C6Dh |  |  | XXh |
| 2C6Eh |  |  | XXh |
| 2C6Fh |  |  | XXh |

X: Undefined
Note:

1. The blank areas are reserved and cannot be accessed by users.

Table 4.8 SFR Information (8) (2C70h to 2CAFh) (1)

| Address | Register | Symbol | After Reset |
| :---: | :---: | :---: | :---: |
| 2C70h | DTC Control Data 6 | DTCD6 | XXh |
| 2C71h |  |  | XXh |
| 2C72h |  |  | XXh |
| 2C73h |  |  | XXh |
| 2C74h |  |  | XXh |
| 2C75h |  |  | XXh |
| 2C76h |  |  | XXh |
| 2C77h |  |  | XXh |
| 2C78h | DTC Control Data 7 | DTCD7 | XXh |
| 2C79h |  |  | XXh |
| 2C7Ah |  |  | XXh |
| 2C7Bh |  |  | XXh |
| 2C7Ch |  |  | XXh |
| 2C7Dh |  |  | XXh |
| 2C7Eh |  |  | XXh |
| 2C7Fh |  |  | XXh |
| 2C80h | DTC Control Data 8 | DTCD8 | XXh |
| 2C81h |  |  | XXh |
| 2C82h |  |  | XXh |
| 2C83h |  |  | XXh |
| 2C84h |  |  | XXh |
| 2C85h |  |  | XXh |
| 2C86h |  |  | XXh |
| 2C87h |  |  | XXh |
| 2C88h | DTC Control Data 9 | DTCD9 | XXh |
| 2C89h |  |  | XXh |
| 2C8Ah |  |  | XXh |
| 2C8Bh |  |  | XXh |
| 2C8Ch |  |  | XXh |
| 2C8Dh |  |  | XXh |
| 2C8Eh |  |  | XXh |
| 2C8Fh |  |  | XXh |
| 2C90h | DTC Control Data 10 | DTCD10 | XXh |
| 2C91h |  |  | XXh |
| 2C92h |  |  | XXh |
| 2C93h |  |  | XXh |
| 2C94h |  |  | XXh |
| 2C95h |  |  | XXh |
| 2C96h |  |  | XXh |
| 2C97h |  |  | XXh |
| 2C98h | DTC Control Data 11 | DTCD11 | XXh |
| 2C99h |  |  | XXh |
| 2C9Ah |  |  | XXh |
| 2C9Bh |  |  | XXh |
| 2C9Ch |  |  | XXh |
| 2C9Dh |  |  | XXh |
| 2C9Eh |  |  | XXh |
| 2C9Fh |  |  | XXh |
| 2CAOh | DTC Control Data 12 | DTCD12 | XXh |
| 2CA1h |  |  | XXh |
| 2CA2h |  |  | XXh |
| 2CA3h |  |  | XXh |
| 2CA4h |  |  | XXh |
| 2CA5h |  |  | XXh |
| 2CA6h |  |  | XXh |
| 2CA7h |  |  | XXh |
| 2CA8h | DTC Control Data 13 | DTCD13 | XXh |
| 2CA9h |  |  | XXh |
| 2CAAh |  |  | XXh |
| 2CABh |  |  | XXh |
| 2CACh |  |  | XXh |
| 2CADh |  |  | XXh |
| 2CAEh |  |  | XXh |
| 2CAFh |  |  | XXh |

X: Undefined
Note:

1. The blank areas are reserved and cannot be accessed by users.

Table 4.9 SFR Information (9) (2CBOh to 2CEFh) (1)

| Address | Register | Symbol | After Reset |
| :---: | :---: | :---: | :---: |
| 2CB0h | DTC Control Data 14 | DTCD14 | XXh |
| 2CB1h |  |  | XXh |
| 2CB2h |  |  | XXh |
| 2CB3h |  |  | XXh |
| 2CB4h |  |  | XXh |
| 2CB5h |  |  | XXh |
| 2CB6h |  |  | XXh |
| 2CB7h |  |  | XXh |
| 2CB8h | DTC Control Data 15 | DTCD15 | XXh |
| 2CB9h |  |  | XXh |
| 2CBAh |  |  | XXh |
| 2CBBh |  |  | XXh |
| 2CBCh |  |  | XXh |
| 2CBDh |  |  | XXh |
| 2CBEh |  |  | XXh |
| 2CBFh |  |  | XXh |
| 2CC0h | DTC Control Data 16 | DTCD16 | XXh |
| 2CC1h |  |  | XXh |
| 2CC2h |  |  | XXh |
| 2CC3h |  |  | XXh |
| 2CC4h |  |  | XXh |
| 2CC5h |  |  | XXh |
| 2CC6h |  |  | XXh |
| 2CC7h |  |  | XXh |
| 2CC8h | DTC Control Data 17 | DTCD17 | XXh |
| 2CC9h |  |  | XXh |
| 2CCAh |  |  | XXh |
| 2CCBh |  |  | XXh |
| 2CCCh |  |  | XXh |
| 2CCDh |  |  | XXh |
| 2CCEh |  |  | XXh |
| 2CCFh |  |  | XXh |
| 2CDOh | DTC Control Data 18 | DTCD18 | XXh |
| 2CD1h |  |  | XXh |
| 2CD2h |  |  | XXh |
| 2CD3h |  |  | XXh |
| 2CD4h |  |  | XXh |
| 2CD5h |  |  | XXh |
| 2CD6h |  |  | XXh |
| 2CD7h |  |  | XXh |
| 2CD8h | DTC Control Data 19 | DTCD19 | XXh |
| 2CD9h |  |  | XXh |
| 2CDAh |  |  | XXh |
| 2CDBh |  |  | XXh |
| 2CDCh |  |  | XXh |
| 2CDDh |  |  | XXh |
| 2CDEh |  |  | XXh |
| 2CDFh |  |  | XXh |
| 2CE0h | DTC Control Data 20 | DTCD20 | XXh |
| 2CE1h |  |  | XXh |
| 2CE2h |  |  | XXh |
| 2CE3h |  |  | XXh |
| 2CE4h |  |  | XXh |
| 2CE5h |  |  | XXh |
| 2CE6h |  |  | XXh |
| 2CE7h |  |  | XXh |
| 2CE8h | DTC Control Data 21 | DTCD21 | XXh |
| 2CE9h |  |  | XXh |
| 2CEAh |  |  | XXh |
| 2CEBh |  |  | XXh |
| 2CECh |  |  | XXh |
| 2CEDh |  |  | XXh |
| 2CEEh |  |  | XXh |
| 2CEFh |  |  | XXh |

X: Undefined
Note:

1. The blank areas are reserved and cannot be accessed by users.

Table 4.10 SFR Information (10) (2CFOh to 2D2Fh) (1)

| Address | Register | Symbol | After Reset |
| :---: | :---: | :---: | :---: |
| 2CF0h | DTC Control Data 22 | DTCD22 | XXh |
| 2CF1h |  |  | XXh |
| 2CF2h |  |  | XXh |
| 2CF3h |  |  | XXh |
| 2CF4h |  |  | XXh |
| 2CF5h |  |  | XXh |
| 2CF6h |  |  | XXh |
| 2CF7h |  |  | XXh |
| 2CF8h | DTC Control Data 23 | DTCD23 | XXh |
| 2CF9h |  |  | XXh |
| 2CFAh |  |  | XXh |
| 2CFBh |  |  | XXh |
| 2CFCh |  |  | XXh |
| 2CFDh |  |  | XXh |
| 2CFEh |  |  | XXh |
| 2CFFh |  |  | XXh |
| 2D00h | Baseband Control Register | BBCON | 00h |
| 2D01h | Transmit/Receive Reset Register | BBTXRXRST | 00h |
| 2D02h | Transmit/Receive Mode Register 0 | BBTXRXMODE0 | 00h |
| 2D03h | Transmit/Receive Mode Register 1 | BBTXRXMODE1 | 00h |
| 2D04h | Receive Frame Length Register | BBRXFLEN | 00h |
| 2D05h | Receive Data Counter Register | BBRXCOUNT | 00h |
| 2D06h | RSSI/CCA Result Register | BBRSSICCARSLT | 00h |
| 2D07h | Transmit/Receive Status Register 0 | BBTXRXST0 | 80h |
| 2D08h | Transmit Frame Length Register | BBTXFLEN | 00h |
| 2D09h | Transmit/Receive Mode Register 2 | BBTXRXMODE2 | 30h |
| 2D0Ah | Transmit/Receive Mode Register 3 | BBTXRXMODE3 | 00h |
| 2D0Bh | Receive Level Threshold Set Register | BBLVLVTH | 80h |
| 2D0Ch | Transmit/Receive Control Register | BBTXRXCON | 00h |
| 2D0Dh | CSMA Control Register 0 | BBCSMACONO | 00h |
| 2D0Eh | CCA Level Threshold Set Register | BBCCAVTH | 80h |
| 2D0Fh | Transmit/Receive Status Register 1 | BBTXRXST1 | 00h |
| 2D10h | RF Control Register | BBRFCON | 00h |
| 2D11h | Transmit/Receive Mode Register 4 | BBTXRXMODE4 | 00h |
| 2D12h | CSMA Control Register 1 | BBCSMACON1 | 9Ch |
| 2D13h | CSMA Control Register 2 | BBCSMACON2 | 05h |
| 2D14h | PAN Identifier Register | BBPANID | 00h |
| 2D15h |  |  | 00h |
| 2D16h | Short Address Register | BBSHORTAD | 00h |
| 2D17h |  |  | 00h |
| 2D18h | Extended Address Register | BBEXTENDADO | 00h |
| 2D19h |  |  | 00h |
| 2D1Ah |  | BBEXTENDAD1 | 00h |
| 2D1Bh |  |  | 00h |
| 2D1Ch |  | BBEXTENDAD2 | 00h |
| 2D1Dh |  |  | 00h |
| 2D1Eh |  | BBEXTENDAD3 | 00h |
| 2D1Fh |  |  | 00h |
| 2D20h | Timer Read-Out Register 0 | BBTIMEREADO | 00h |
| 2D21h |  |  | 00h |
| 2D22h | Timer Read-Out Register 1 | BBTIMEREAD1 | 00h |
| 2D23h |  |  | 00h |
| 2D24h | Timer Compare 0 Register 0 | BBCOMPOREG0 | 00h |
| 2D25h |  |  | 00h |
| 2D26h | Timer Compare 0 Register 1 | BBCOMP0REG1 | 00h |
| 2D27h |  |  | 00h |
| 2D28h | Timer Compare 1 Register 0 | BBCOMP1REG0 | 00h |
| 2D29h |  |  | 00h |
| 2D2Ah | Timer Compare 1 Register 1 | BBCOMP1REG1 | 00h |
| 2D2Bh |  |  | 00h |
| 2D2Ch | Timer Compare 2 Register 0 | BBCOMP2REG0 | 00h |
| 2D2Dh |  |  | 00h |
| 2D2Eh | Timer Compare 2 Register 1 | BBCOMP2REG1 | 00h |
| 2D2Fh |  |  | 00h |

X: Undefined
Note:

1. The blank areas are reserved and cannot be accessed by users.

Table 4.11 SFR Information (11) (2D30h to 2FFFh) (1)

| Address | Register | Symbol | After Reset |
| :---: | :--- | :--- | :--- |
| 2D30h | Time Stamp Register 0 | BBTSTAMP0 | 00h |
| 2D31h |  |  | 00h |


| 2D45 h |  |  |  |
| :--- | :--- | :--- | :--- |
| 2D46h | Automatic ACK Response Timing Adjustment Register | BBACKRTNTIMG | 22 h |
| 2D47h |  |  |  |


| 2D63h |  |  |  |
| :---: | :---: | :---: | :---: |
| 2D64h |  |  |  |
| 2D65h |  |  |  |
| 2D66h |  |  |  |
| 2D67h |  |  |  |
| 2D68h | Verification Mode Set Register | BBEVAREG | 00h |
| 2D69h |  |  |  |
| 2D6Ah |  |  |  |
| 2D6Bh |  |  |  |
| 2D6Ch |  |  |  |
| 2D6Dh |  |  |  |
| 2D6Eh |  |  |  |
| 2D6Fh |  |  |  |
| 2D70h |  |  |  |
| 2D71h |  |  |  |
| 2D72h |  |  |  |
| 2D73h |  |  |  |
| 2D74h |  |  |  |
| 2D75h |  |  |  |
| 2D76h | IDLE Wait Set Register | BBIDELWAIT | 01h |
| 2D77h |  |  |  |
| 2D78h |  |  |  |
| 2D79h |  |  |  |
| 2D7Ah | ANTSW Output Timing Set Register | BBANTSWTIMG | 72h |
| 2D7Bh |  |  |  |
| 2D7Ch | RF Initial Set Register | BBRFINI | XXh |
| 2D7Dh |  |  | XXh |
| 2D7Eh |  |  |  |
| 2D7Fh |  |  |  |
| 2D80h |  |  |  |
| 2D81h |  |  |  |
| 2D82h | ANTSW Control Register | BBANTSWCON | 00h |
| 2D83h |  |  |  |


| 2DFFh |  |  |  |
| :---: | :---: | :---: | :---: |
| 2E00h | Transmit RAM | TRANSMIT_RAM_START |  |
| : | Transmit RAM |  |  |
| 2E7Eh | Transmit RAM | TRANSMIT_RAM_END |  |
| 2E7Fh |  |  |  |
| 2D80h | Receive RAM | RECIEVE_RAM_START |  |
| : | Receive RAM |  |  |
| 2EFEh | Receive RAM | RECIEVE_RAM_END |  |
| 2EFFh |  |  |  |
| 2F00h |  |  |  |



X: Undefined
Note:
The blank areas are reserved and cannot be accessed by users.

Table 4.12 ID Code Areas and Option Function Select Area

| Address | Area Name | Symbol | After Reset |
| :---: | :---: | :---: | :---: |
| : |  |  |  |
| FFDBh | Option Function Select Register 2 | OFS2 | (Note 1) |
| : |  |  |  |
| FFDFh | TD1 |  | (Note 2) |
| : |  |  |  |
| FFE3h | ID2 |  | (Note 2) |
| : |  |  |  |
| FFEBh | TD3 |  | (Note 2) |
| : |  |  |  |
| FFEFh | ID4 |  | (Note 2) |
| : |  |  |  |
| FFF3h | ID5 |  | (Note 2) |
| : |  |  |  |
| FFF7h | ID6 |  | (Note 2) |
| : |  |  |  |
| FFFBh | TD7 |  | (Note 2) |
| : |  |  |  |
| FFFFh | Option Function Select Register | OFS | (Note 1) |

Notes:

1. The option function select area is allocated in the flash memory, not in the SFRs. Set appropriate values as ROM data by a program Do not write additions to the option function select area. If the block including the option function select area is erased, the option function select area is set to FFh.
At shipment, the option function select area is set to FFh. It is set to the written value after written by the user
2. The ID code areas are allocated in the flash memory, not in the SFRs. Set appropriate values as ROM data by a program.

Do not write additions to the ID code areas. If the block including the ID code areas is erased, the ID code areas are set to FFh. At shipment, the ID code areas are set to FFh. They are set to the written value after written by the user.

## 5. Electrical Characteristics

Table 5.1 Absolute Maximum Ratings

| Symbol |  | Parameter | Condition | Rated Value | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| VCC | Digital supply voltage |  |  | -0.3 to 3.8 | V |
| VCCRF | Analog supply voltage |  |  | -0.3 to 3.8 | V |
| VI | Input voltage | RESET, MODE, P0_4, P1, P3_0, P3_1, P3_3 to P3_5, P3_7, P4_3 to P4_5 |  | -0.3 to Vcc +0.3 | V |
| Vo | Output voltage | P0_4, P1, P3_0, P3_1, P3_3 to P3_5, P3_7, P4_3 to P4_5 |  | -0.3 to Vcc +0.3 | V |
| VRFIO | RF I/O pins | RFIOP, RFION |  | -0.3 to 2.1 | V |
| VTESTIO | Test ports | IFRXTP, IFRXTN |  | -0.3 to 2.1 | V |
| VANAIN | 1.5 V analog supply (input) | VREG1, VREG2, VREG3, VREG4 |  | -0.3 to 2.1 | V |
| VANAOUT | 1.5 V analog supply (output) | VREGOUT1, VREGOUT2, VREGOUT3 |  | -0.3 to 2.1 | V |
| VXINOUT | Main clock I/O | XIN, XOUT |  | -0.3 to 2.1 | V |
| Pd | Power dissipation |  | $-20^{\circ} \mathrm{C} \leq$ Topr $\leq 85^{\circ} \mathrm{C}$ | 300 | mW |
| Topr | Operating ambient temperature | (1) During MCU operation under the conditions other than (2) and (3) below. |  | -20 to 85 | ${ }^{\circ} \mathrm{C}$ |
|  |  | (2) During programming and erasing of the flash memory using a serial programmer or parallel programmer. |  | 0 to 60 |  |
|  |  | (3) During on-chip debugging with the E8a emulator connected |  | 10 to 35 |  |
| Tstg | Storage temperature |  |  | -65 to 150 | ${ }^{\circ} \mathrm{C}$ |

Table 5.2 Recommended Operating Conditions (1)

| Symbol | Parameter |  |  |  | Conditions | Standard |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | Min. | Typ. | Max. |  |
| VCC | Digital supply voltage | (1) During MCU operation under the conditions other than (2) and (3) below. |  |  |  |  | 1.8 | 3.3 | 3.6 | V |
|  |  | (2) During programming and erasing of the flash memory using a serial programmer or parallel programmer. |  |  |  | 2.7 | - | 3.6 |  |  |
|  |  | (3) During on-chip debugging with the E8a emulator connected |  |  |  | 2.7 | - | 3.6 |  |  |
| VCCRF | Analog supply voltage |  |  |  |  | 1.8 | 3.3 | 3.6 | V |  |
| VSS/ <br> VSS2/ <br> VSSRF/ <br> VSSRF1/ <br> VSSRF2/ <br> DIEGND | Supply voltage | VSS1, VSS2, VSSRF, VSSRF1, VSSRF2, DIEGND |  |  |  | - | 0 | - | V |  |
| VIH | Input "H" voltage | Other than CMOS input |  |  |  | 0.8 Vcc | - | Vcc | V |  |
|  |  | CMOS input | Inputlevel switching function (I/O port) | Input level selection: 0.35 Vcc | $2.7 \mathrm{~V} \leq \mathrm{Vcc} \leq 3.6 \mathrm{~V}$ | 0.55 Vcc | - | Vcc | V |  |
|  |  |  |  |  | $1.8 \mathrm{~V} \leq \mathrm{Vcc}<2.7 \mathrm{~V}$ | 0.65 Vcc | - | Vcc | V |  |
|  |  |  |  | Input level selection: 0.5 Vcc | $2.7 \mathrm{~V} \leq \mathrm{Vcc} \leq 3.6 \mathrm{~V}$ | 0.7 Vcc | - | Vcc | V |  |
|  |  |  |  |  | $1.8 \mathrm{~V} \leq \mathrm{Vcc}<2.7 \mathrm{~V}$ | 0.8 Vcc | - | Vcc | V |  |
|  |  |  |  | Input level selection:$0.7 \mathrm{Vcc}$ | $2.7 \mathrm{~V} \leq \mathrm{Vcc} \leq 3.6 \mathrm{~V}$ | 0.85 Vcc | - | Vcc | V |  |
|  |  |  |  |  | $1.8 \mathrm{~V} \leq \mathrm{Vcc}<2.7 \mathrm{~V}$ | 0.85 Vcc | - | Vcc | V |  |
| VIL | Input "L" voltage | Other than CMOS input |  |  |  | 0 | - | 0.2 Vcc | V |  |
|  |  | CMOS input | Inputlevel switching function (I/O port) | Input level selection:$0.35 \mathrm{Vcc}$ | $2.7 \mathrm{~V} \leq \mathrm{Vcc} \leq 3.6 \mathrm{~V}$ | 0 | - | 0.2 Vcc | V |  |
|  |  |  |  |  | $1.8 \mathrm{~V} \leq \mathrm{Vcc}<2.7 \mathrm{~V}$ | 0 | - | 0.2 Vcc | V |  |
|  |  |  |  | Input level selection: 0.5 Vcc | $2.7 \mathrm{~V} \leq \mathrm{Vcc} \leq 3.6 \mathrm{~V}$ | 0 | - | 0.3 Vcc | V |  |
|  |  |  |  |  | $1.8 \mathrm{~V} \leq \mathrm{Vcc}<2.7 \mathrm{~V}$ | 0 | - | 0.2 Vcc | V |  |
|  |  |  |  | Input level selection:$0.7 \text { Vcc }$ | $2.7 \mathrm{~V} \leq \mathrm{Vcc} \leq 3.6 \mathrm{~V}$ | 0 | - | 0.45 Vcc | V |  |
|  |  |  |  |  | $1.8 \mathrm{~V} \leq \mathrm{Vcc}<2.7 \mathrm{~V}$ | 0 | - | 0.35 Vcc | V |  |
| IOH (sum) | Peak sum output " H " current |  | Sum of all pins lOH (peak) |  |  | - | - | -160 | mA |  |
| IOH (sum) | Average sum output "H" current |  | Sum of all pins $\mathrm{IOH}(\mathrm{avg})$ |  |  | - | - | -80 | mA |  |
| IOH(peak) | Peak output "H" current |  | Drive capacity Low |  |  | - | - | -10 | mA |  |
|  |  |  | Drive capacity High |  |  | - | - | -40 | mA |  |
| loh(avg) | Average output " H " current |  | Drive capacity Low |  |  | - | - | -5 | mA |  |
|  |  |  | Drive capacity High |  |  | - | - | -20 | mA |  |
| IOL(sum) | Peak sum output "L" current |  | Sum of all pins IOL(peak) |  |  | - | - | 160 | mA |  |
| IOL(sum) | Average sum output "L" current |  | Sum of all pins loL(avg) |  |  | - | - | 80 | mA |  |
| IOL(peak) | Peak output "L" current |  | Drive capacity Low |  |  | - | - | 10 | mA |  |
|  |  |  | Drive capac | city High |  | - | - | 40 | mA |  |
| IOL(avg) | Average output " L " current |  | Drive capacity Low |  |  | - | - | 5 | mA |  |
|  |  |  | Drive capacity High |  |  | - | - | 20 | mA |  |
| f (XIN) | XIN clock input oscillation frequency |  |  |  | $1.8 \mathrm{~V} \leq \mathrm{Vcc} \leq 3.6 \mathrm{~V}$ | - | 16 | - | MHz |  |
| f (XCIN) | XCIN clock input oscillation frequency |  |  |  | $1.8 \mathrm{~V} \leq \mathrm{Vcc} \leq 3.6 \mathrm{~V}$ | 30 | 32.768 | 35 | kHz |  |
| - | System clock frequency |  | $f(X I N)=16 \mathrm{MHz}$ |  | $1.8 \mathrm{~V} \leq \mathrm{Vcc} \leq 3.6 \mathrm{~V}$ | - | - | 16 | MHz |  |
| f(BCLK) | CPU clock frequency |  | $f(X I N)=16 \mathrm{MHz}$ |  | $2.7 \mathrm{~V} \leq \mathrm{Vcc} \leq 3.6 \mathrm{~V}$ | - | - | 16 | MHz |  |
|  |  |  | $2.2 \mathrm{~V} \leq \mathrm{Vcc}<2.7 \mathrm{~V}$ | - | - | 8 |  |  |
|  |  |  | $1.8 \mathrm{~V} \leq \mathrm{Vcc}<2.2 \mathrm{~V}$ | - | - | 4 |  |  |

Notes:

1. $\mathrm{VcC}=1.8$ to 3.6 V and $\mathrm{Topr}=-20^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$, unless otherwise specified.
2. The average output current indicates the average value of current measured during 100 ms .


Figure 5.1 Ports P0, P1, P3 and P4 Timing Measurement Circuit

Table 5.3 Flash Memory (Program ROM) Electrical Characteristics

| Symbol | Parameter | Conditions | Standard |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| - | Program/erase endurance (2) |  | 1,000 ${ }^{(3)}$ | - | - | times |
| - | Byte program time |  | - | 80 | 500 | $\mu \mathrm{S}$ |
| - | Block erase time |  | - | 0.3 | - | s |
| td(SR-SUS) | Time delay from suspend request until suspend |  | - | - | $\begin{gathered} 5+\text { CPU clock } \\ \times 3 \text { cycles } \\ \hline \end{gathered}$ | ms |
| - | Interval from erase start/restart until following suspend request |  | 0 | - | - | $\mu \mathrm{s}$ |
| - | Time from suspend until erase restart |  | - | - | $\begin{array}{\|c} \hline 30 \\ \hline \end{array}+\text { CPU clock }$ | $\mu \mathrm{S}$ |
| td(CMDRSTREADY) | Time from when command is forcibly stopped until reading is enabled |  | - | - | $\begin{array}{\|c} \hline 30 \\ \hline \end{array}+\text { CPU clock }$ | $\mu \mathrm{S}$ |
| - | Program, erase voltage | CPU rewrite mode | 1.8 | - | 3.6 | V |
|  |  | Standard serial I/O mode | 2.7 | - | 3.6 |  |
|  |  | Parallel I/O mode | 2.7 | - | 3.6 |  |
| - | Read voltage |  | 1.8 | - | 3.6 | V |
| - | Program, erase temperature |  | 0 | - | 60 | ${ }^{\circ} \mathrm{C}$ |
| - | Data hold time ${ }^{(7)}$ | Ambient temperature $=55^{\circ} \mathrm{C}$ | 20 | - | - | year |

Notes:

1. $V c c=2.7$ to 3.6 V and $\mathrm{T}_{\mathrm{opr}}=0$ to $60^{\circ} \mathrm{C}$, unless otherwise specified.
2. Definition of programming/erasure endurance

The programming and erasure endurance is defined on a per-block basis.
If the programming and erasure endurance is $n(n=1,000)$, each block can be erased $n$ times. For example, if 1,024 1-byte writes are performed to different addresses in block A, a 1 Kbyte block, and then the block is erased, the programming/erasure endurance still stands at one. However, the same address must not be programmed more than once per erase operation (overwriting prohibited).
3. Endurance to guarantee all electrical characteristics after program and erase. (1 to Min. value can be guaranteed.)
4. In a system that executes multiple programming operations, the actual erasure count can be reduced by writing to sequential addresses in turn so that as much of the block as possible is used up before performing an erase operation. For example, when programming groups of 16 bytes, the effective number of rewrites can be minimized by programming up to 128 groups before erasing them all in one operation. It is also advisable to retain data on the erasure endurance of each block and limit the number of erase operations to a certain number.
5. If an error occurs during block erase, attempt to execute the clear status register command, then execute the block erase command at least three times until the erase error does not occur.
6. Customers desiring program/erase failure rate information should contact their Renesas technical support representative.
7. The data hold time includes time that the power supply is off or the clock is not supplied.

Table 5.4 Flash Memory (Data flash Block A to Block D) Electrical Characteristics

| Symbol | Parameter | Conditions | Standard |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| - | Program/erase endurance (2) |  | 10,000 (3) | - | - | times |
| - | Byte program time (program/erase endurance $\leq 1,000$ times) |  | - | 160 | 1500 | $\mu \mathrm{S}$ |
| - | Byte program time (program/erase endurance $>1,000$ times) |  | - | 300 | 1500 | $\mu \mathrm{s}$ |
| - | Block erase time (program/erase endurance $\leq 1,000$ times) |  | - | 0.2 | 1 | S |
| - | Block erase time (program/erase endurance $>1,000$ times) |  | - | 0.3 | 1 | s |
| td(SR-SUS) | Time delay from suspend request until suspend |  | - | - | $\begin{gathered} 5+\text { CPU clock } \\ \times 3 \text { cycles } \\ \hline \end{gathered}$ | ms |
| - | Interval from erase start/restart until following suspend request |  | 0 | - | - | $\mu \mathrm{S}$ |
| - | Time from suspend until erase restart |  | - | - | $\begin{gathered} 30 \end{gathered}+\text { CPU clock }$ | $\mu \mathrm{s}$ |
| td(CMDRSTREADY) | Time from when command is forcibly stopped until reading is enabled |  | - | - | $\begin{gathered} 30+\text { CPU clock } \\ \times 1 \text { cycle } \\ \hline \end{gathered}$ | $\mu \mathrm{s}$ |
| - | Program, erase voltage | CPU rewrite mode | 1.8 | - | 3.6 | V |
|  |  | Standard serial I/O mode | 2.7 | - | 3.6 |  |
|  |  | Parallel I/O mode | 2.7 | - | 3.6 |  |
| - | Read voltage |  | 1.8 | - | 3.6 | V |
| - | Program, erase temperature | CPU rewrite mode | -20 | - | 85 | ${ }^{\circ} \mathrm{C}$ |
|  |  | Standard serial I/O mode | 0 | - | 60 |  |
|  |  | Parallel I/O mode | 0 | - | 60 |  |
| - | Data hold time ${ }^{(7)}$ | Ambient temperature $=55^{\circ} \mathrm{C}$ | 20 | - | - | year |

Notes:

1. $\mathrm{Vcc}=1.8$ to 3.6 V and $\mathrm{Topr}=-20^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$, unless otherwise specified
2. Definition of programming/erasure endurance

The programming and erasure endurance is defined on a per-block basis.
If the programming and erasure endurance is $n(n=10,000)$, each block can be erased $n$ times. For example, if 1,024 1-byte writes are performed to different addresses in block A, a 1 Kbyte block, and then the block is erased, the programming/erasure endurance still stands at one. However, the same address must not be programmed more than once per erase operation (overwriting prohibited).
3. Endurance to guarantee all electrical characteristics after program and erase. ( 1 to Min. value can be guaranteed.)
4. In a system that executes multiple programming operations, the actual erasure count can be reduced by writing to sequential addresses in turn so that as much of the block as possible is used up before performing an erase operation. For example, when programming groups of 16 bytes, the effective number of rewrites can be minimized by programming up to 128 groups before erasing them all in one operation. In addition, averaging the erasure endurance between blocks A to D can further reduce the actual erasure endurance. It is also advisable to retain data on the erasure endurance of each block and limit the number of erase operations to a certain number
5. If an error occurs during block erase, attempt to execute the clear status register command, then execute the block erase command at least three times until the erase error does not occur.
6. Customers desiring program/erase failure rate information should contact their Renesas technical support representative.
7. The data hold time includes time that the power supply is off or the clock is not supplied.


FST6, FST7: Bit in FST register
FMR21: Bit in FMR2 register
Figure 5.2 Time delay until Suspend

Table 5.5 Voltage Detection 0 Circuit Electrical Characteristics

| Symbol | Parameter | Condition | Standard |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| V det0 | Voltage detection level Vdet0_0 |  | 1.80 | 1.90 | 2.05 | V |
| - | Voltage detection 0 circuit response time ${ }^{(3)}$ | At the falling of Vcc from 3.6 V to (Vdet0_0-0.1) V | - | 6 | 150 | $\mu \mathrm{S}$ |
| - | Voltage detection circuit self power consumption | VCA25 = 1, Vcc $=3.0 \mathrm{~V}$ | - | 1.5 | - | $\mu \mathrm{A}$ |
| $\operatorname{td}(\mathrm{E}-\mathrm{A})$ | Waiting time until voltage detection circuit operation starts (2) |  | - | - | 100 | $\mu \mathrm{S}$ |

Notes:

1. The measurement condition is $\mathrm{Vcc}=1.8 \mathrm{~V}$ to 3.6 V and $\mathrm{Topr}=-20^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$.
2. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA25 bit in the VCA2 register to 0 .
3. Time until the voltage monitor 0 reset is generated after the voltage passes Vdeto.

Table 5.6 Voltage Detection 1 Circuit Electrical Characteristics

| Symbol | Parameter | Condition | Standard |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| Vdet1 | Voltage detection level Vdet1_2 (2) | At the falling of Vcc | 2.30 | 2.50 | 2.70 | V |
|  | Voltage detection level Vdet1_5 ${ }^{(2)}$ | At the falling of Vcc | 2.75 | 2.95 | 3.15 | V |
| - | Hysteresis width at the rising of Vcc in voltage detection 1 circuit |  | - | 0.07 | - | V |
| - | Voltage detection 1 circuit response time (3) | At the falling of Vcc from 3.6 V to (Vdet1_0-0.1) V | - | 60 | 150 | $\mu \mathrm{s}$ |
| - | Voltage detection circuit self power consumption | VCA26 = 1, Vcc $=3.0 \mathrm{~V}$ | - | 1.7 | - | $\mu \mathrm{A}$ |
| $\operatorname{td}(\mathrm{E}-\mathrm{A})$ | Waiting time until voltage detection circuit operation starts (4) |  | - | - | 100 | $\mu \mathrm{S}$ |

Notes:

1. The measurement condition is $\mathrm{Vcc}=1.8 \mathrm{~V}$ to 3.6 V and $\mathrm{T}_{\mathrm{opr}}=-20^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$.
2. Select the voltage detection level with bits VD1S0 to VD1S3 in the VD1LS register.
3. Time until the voltage monitor 1 interrupt request is generated after the voltage passes Vdet1.
4. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA26 bit in the VCA2 register to 0 .

Table 5.7 Power-on Reset Circuit (2)

| Symbol | Parameter | Condition | Standard |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| trth | External power Vcc rise gradient | (1) | 0 | - | 50,000 | $\mathrm{mV} / \mathrm{msec}$ |

Notes:

1. The measurement condition is $\mathrm{Topr}=-20^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$, unless otherwise specified.
2. To use the power-on reset function, enable voltage monitor 0 reset by setting the LVDAS bit in the OFS register to 0 .


Figure 5.3 Power-on Reset Circuit Electrical Characteristics

Table 5.8 System Clock Low-Speed On-Chip Oscillator Circuit Electrical Characteristics

| Symbol | Parameter | Condition | Standard |  | Unit |  |
| :--- | :--- | :--- | :---: | :---: | :---: | :---: |
|  |  |  |  | Min. |  | Max. |
|  |  |  |  |  |  |  |
| fOCO-S | Low-speed on-chip oscillator frequency |  | 100 | 125 | 150 | kHz |
| - | Oscillation stability time |  | - | 30 | 100 | $\mu \mathrm{~s}$ |

Note:

1. $\mathrm{Vcc}=1.8 \mathrm{~V}$ to 3.6 V and $\mathrm{T}_{\mathrm{opr}}=-20^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$, unless otherwise specified.

Table 5.9 Watchdog Timer Low-Speed On-Chip Oscillator Circuit Electrical Characteristics

| Symbol | Parameter | Condition | Standard |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| fOCO-WDT | Low-speed on-chip oscillator frequency |  | 60 | 125 | 250 | kHz |
| - | Oscillation stability time |  | - | 30 | 100 | $\mu \mathrm{s}$ |

Note:

1. $\mathrm{Vcc}=1.8 \mathrm{~V}$ to 3.6 V and $\mathrm{Topr}=-20^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$, unless otherwise specified.

Table 5.10 Power Supply Circuit Timing Characteristics

| Symbol | Parameter | Condition | Standard |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| td(P-R) | Time for internal power supply stabilization during power-on (2) |  | - | - | 2,000 | $\mu \mathrm{S}$ |

Notes:

1. The measurement condition is $\mathrm{VCC}=1.8$ to 3.6 V and $\mathrm{Topr}=25^{\circ} \mathrm{C}$.
2. Waiting time until the internal power supply generation circuit stabilizes during power-on.

Table 5.11 Timing Requirements of Synchronous Serial Communication Unit (SSU) (1)

| Symbol | Parameter |  | Conditions | Standard |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| tSUCYC | SSCK clock cycle time |  |  |  | 4 | - | - | tcyc ${ }^{(2)}$ |
| tHI | SSCK clock "H" width |  |  | 0.4 | - | 0.6 | tsucyc |
| tLO | SSCK clock "L" width |  |  | 0.4 | - | 0.6 | tsucyc |
| tRISE | SSCK clock rising time | Master |  | - | - | 1 | tcyc (2) |
|  |  | Slave |  | - | - | 1 | $\mu \mathrm{s}$ |
| tFALL | SSCK clock falling time | Master |  | - | - | 1 | tcyc (2) |
|  |  | Slave |  | - | - | 1 | $\mu \mathrm{s}$ |
| tsu | SSO, SSI data input setup time |  |  | 100 | - | - | ns |
| th | SSO, SSI data input hold time |  |  | 1 | - | - | tcyc (2) |
| tLEAD | $\overline{\text { SCS }}$ setup time | Slave |  | 1tcyc +50 | - | - | ns |
| tLAG | $\overline{\text { SCS }}$ hold time | Slave |  | 1tcyc +50 | - | - | ns |
| tod | SSO, SSI data output delay time |  |  | - | - | 1.5 | tcyc (2) |
| tsA | SSI slave access time |  | $2.7 \mathrm{~V} \leq \mathrm{Vcc} \leq 3.6 \mathrm{~V}$ | - | - | $1.5 \mathrm{tcYc}+100$ | ns |
|  |  |  | $1.8 \mathrm{~V} \leq \mathrm{Vcc}<2.7 \mathrm{~V}$ | - | - | 1.5tcyc + 200 | ns |
| tor | SSI slave out open time |  | $2.7 \mathrm{~V} \leq \mathrm{Vcc} \leq 3.6 \mathrm{~V}$ | - | - | 1.5tCYC + 100 | ns |
|  |  |  | $1.8 \mathrm{~V} \leq \mathrm{Vcc}<2.7 \mathrm{~V}$ | - | - | $1.5 \mathrm{tcYc}+200$ | ns |

Notes:

1. $\mathrm{Vcc}=1.8 \mathrm{~V}$ to 3.6 V and $\mathrm{Topr}=-20^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$, unless otherwise specified.
2. $1 \mathrm{tcyc}=1 / \mathrm{f} 1(\mathrm{~s})$

4-Wire Bus Communication Mode, Master, CPHS = 1


4-Wire Bus Communication Mode, Master, CPHS = 0


CPHS, CPOS: Bits in SSMR register

Figure $5.4 \quad$ I/O Timing of Synchronous Serial Communication Unit (SSU) (Master)

4-Wire Bus Communication Mode, Slave, CPHS = 1


4-Wire Bus Communication Mode, Slave, CPHS $=0$


CPHS, CPOS: Bits in SSMR register

Figure $5.5 \quad$ I/O Timing of Synchronous Serial Communication Unit (SSU) (Slave)


Figure 5.6 I/O Timing of Synchronous Serial Communication Unit (SSU) (Clock Synchronous Communication Mode)

Table 5.12 Timing Requirements of $\mathrm{I}^{2} \mathrm{C}$ bus Interface

| Symbol | Parameter | Condition | Standard |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| tscL | SCL input cycle time |  | 12tcyc + 600 (2) | - | - | ns |
| tSCLH | SCL input "H" width |  | $3 \mathrm{tcyc}+300$ (2) | - | - | ns |
| tSCLL | SCL input "L" width |  | $5 \mathrm{tcyc}+500$ (2) | - | - | ns |
| tsf | SCL, SDA input fall time |  | - | - | 300 | ns |
| tSP | SCL, SDA input spike pulse rejection time |  | - | - | $1 \mathrm{tCrc}{ }^{(2)}$ | ns |
| tBuF | SDA input bus-free time |  | $5 \mathrm{tcyc}{ }^{(2)}$ | - | - | ns |
| tSTAH | Start condition input hold time |  | $3 \mathrm{tcyc}{ }^{(2)}$ | - | - | ns |
| tstas | Retransmit start condition input setup time |  | $3 \mathrm{tcyc}{ }^{(2)}$ | - | - | ns |
| tSTOP | Stop condition input setup time |  | $3 \mathrm{tcyc}{ }^{(2)}$ | - | - | ns |
| tSDAS | Data input setup time |  | $1 \mathrm{tcyc}+40$ (2) | - | - | ns |
| tSDAH | Data input hold time |  | 10 | - | - | ns |

Notes:

1. $\mathrm{Vcc}=1.8 \mathrm{~V}$ to 3.6 V and $\mathrm{Topr}=-20^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$, unless otherwise specified.
2. $1 \mathrm{tcyc}=1 / \mathrm{f} 1(\mathrm{~s})$


Notes:

1. Start condition
2. Stop condition
3. Retransmit start condition

Figure $5.7 \quad \mathrm{I} / \mathrm{O}$ Timing of $\mathrm{I}^{2} \mathrm{C}$ bus Interface

Table 5.13 Electrical Characteristics (1) [1.8 V $\leq \mathrm{Vcc} \leq 3.6 \mathrm{~V}]$
(Topr $=-20^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$, unless otherwise specified)

| Symbol | Parameter | Condition |  |  | Standard |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | Min. | Typ. | Max. |  |
| ICC | Power supply current Single-chip mode, output pins are open, other pins are VSS | High-speed clock mode XIN clock oscillator on $\mathrm{f}(\mathrm{XIN})=16 \mathrm{MHz}$ XCIN clock oscillator on $\mathrm{f}(\mathrm{XCIN})=32 \mathrm{kHz}$ Low-speed on-chip oscillator on fOCO-S = 125 kHz System clock $=$ XIN | $\begin{aligned} & \text { CPU clock = Divide-by-4, } \\ & (f(B C L K)=4 \mathrm{MHz}) \\ & 1.8 \mathrm{~V} \leq \mathrm{VCC} \leq 3.6 \mathrm{~V} \end{aligned}$ | RF = off | - | 2.5 | - | mA |
|  |  |  |  | RF $=$ idle | - | 4.0 | - | mA |
|  |  |  |  | RF $=$ Tx | - | 18 | - | mA |
|  |  |  |  | RF = Rx (reception standby) | - | 24 | - | mA |
|  |  |  |  | $\begin{array}{\|l\|} \hline \mathrm{RF}=\mathrm{Rx} \\ \text { (reception in progress) } \end{array}$ | - | 25 | - | mA |
|  |  |  | $\begin{aligned} & \text { CPU clock = Divide-by-2, } \\ & \text { (f(BCLK) }=8 \mathrm{MHz}) \\ & 2.2 \mathrm{~V} \leq \mathrm{VCC} \leq 3.6 \mathrm{~V} \end{aligned}$ | RF $=$ off | - | 3.5 | - | mA |
|  |  |  |  | RF $=$ idle | - | 5.0 | - | mA |
|  |  |  |  | RF $=$ Tx | - | 19 | - | mA |
|  |  |  |  | $\begin{array}{\|l\|} \hline \mathrm{RF}=\mathrm{Rx} \\ \text { (reception standby) } \end{array}$ | - | 25 | - | mA |
|  |  |  |  | $\begin{array}{\|l} \hline \mathrm{RF}=\mathrm{Rx} \\ \text { (reception in progress) } \end{array}$ | - | 26 | - | mA |
|  |  |  | $\begin{aligned} & \hline \text { CPU clock = No division } \\ & (\mathrm{f}(\mathrm{BCLK})=16 \mathrm{MHz}) \\ & 2.7 \mathrm{~V} \leq \mathrm{VCC} \leq 3.6 \mathrm{~V} \end{aligned}$ | RF $=$ off | - | 6.0 | - | mA |
|  |  |  |  | RF $=$ idle | - | 7.5 | - | mA |
|  |  |  |  | RF = Tx | - | 21.5 | - | mA |
|  |  |  |  | $\begin{array}{\|l} \hline \mathrm{RF}=\mathrm{Rx} \\ \text { (reception standby) } \end{array}$ | - | 27.5 | - | mA |
|  |  |  |  | $\begin{aligned} & \mathrm{RF}=\mathrm{Rx} \\ & \text { (reception in progress) } \end{aligned}$ | - | 28.5 | - | mA |
|  |  | Low-speed on-chip oscillator mode <br> XIN clock off, XCIN clock off, <br> Low-speed on-chip oscillator on: fOCO-S $=125 \mathrm{kHz}$ System clock $=$ fOCO-S, CPU clock $=$ Divide-by-8 FMR27 $=1$, VCA20 $=0$ (flash memory low-current-consumption read mode) |  | RF = off | - | 80 | - | $\mu \mathrm{A}$ |
|  |  | Low-speed clock mode XIN clock off XCIN clock oscillator on $\mathrm{f}(\mathrm{XCIN})=32 \mathrm{kHz}$ Low-speed on-chip oscillator off System clock = XCIN CPU clock = No division | $\begin{aligned} & \text { FMR27 }=1 \\ & \text { VCA20 }=0 \\ & \text { (flash memory low-current- } \\ & \text { consumption read mode) } \end{aligned}$ | $\mathrm{RF}=\mathrm{off}$ | - | 95 | - | $\mu \mathrm{A}$ |
|  |  |  | $\begin{array}{\|l} \hline \text { FMSTP }=1 \\ \text { VCA20 }=0 \\ \text { (Flash memory off, } \\ \text { program operation on RAM) } \end{array}$ | RF = off | - | 45 | - | $\mu \mathrm{A}$ |
|  |  | Wait mode <br> XIN clock oscillator on: $f(\mathrm{XIN})=16 \mathrm{MHz}$ <br> XCIN clock oscillator on: $\mathrm{f}(\mathrm{XCIN})=32 \mathrm{kHz}$ <br> Low-speed on-chip oscillator on: fOCO-S $=125 \mathrm{kHz}$ <br> System clock = XIN <br> While a WAIT instruction is executed |  | $\begin{aligned} & \mathrm{RF}=\mathrm{Rx} \\ & \text { (reception standby) } \end{aligned}$ | - | 23 | - | mA |
|  |  | Wait mode <br> XIN clock off <br> XCIN clock oscillator on <br> $\mathrm{f}(\mathrm{XCIN})=32 \mathrm{kHz}$ <br> Low-speed on-chip oscillator off <br> System clock = XCIN While a WAIT instruction is executed | $\begin{aligned} & \text { Peripheral function clock on } \\ & \text { VCA26 = VCA25 = } 0 \\ & \text { VCA20 = } 1 \\ & \text { (voltage detection circuit } \\ & \text { stopped, internal power } \\ & \text { consumption enabled) } \\ & \hline \end{aligned}$ | RF = off | - | 6.0 | - | $\mu \mathrm{A}$ |
|  |  |  | Peripheral function clock off VCA26 $=$ VCA25 $=0$ VCA20 = 1 (voltage detection circuit stopped, internal power consumption enabled) | RF = off | - | 4.5 | - | $\mu \mathrm{A}$ |
|  |  | Wait mode XIN clock off XCIN clock oscillator on Low-speed on-chip oscillator on fOCO-S $=125 \mathrm{kHz}$ System clock = fOCO-S While a WAIT instruction is executed | Peripheral function clock on VCA26 $=$ VCA25 $=0$ VCA20 = 1 (voltage detection circuit stopped, internal low power consumption enabled) | RF = off | - | 13.0 | - | $\mu \mathrm{A}$ |
|  |  |  | Peripheral function clock off VCA26 $=$ VCA25 $=0$ VCA20 = 1 (voltage detection circuit stopped, internal low power consumption enabled) | RF = off | - | 7.5 | - | $\mu \mathrm{A}$ |
|  |  | Stop mode (Topr $\left.=25^{\circ} \mathrm{C}\right)$XIN clock off, XCIN clock off,Low-speed on-chip oscillator off,VCA26 $=$ VCA25 $=0$ (voltage detection circuit stopped) |  | RF = off | - | 2.0 | - | $\mu \mathrm{A}$ |

Table 5.14 Electrical Characteristics (2) [2.7 V $\leq \mathrm{Vcc} \leq 3.6 \mathrm{~V}]$

| Symbol | Parameter |  | Condition |  | Standard |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| VOH | Output "H" voltage | $\begin{aligned} & \hline \text { P0_4, P1, P3_0, } \\ & \text { P3_1, P3_3 to P3_5, } \\ & \text { P3_7, P4_3 to P4_5 } \end{aligned}$ |  |  | Drive capacity High | $\mathrm{IOH}=-5 \mathrm{~mA}$ | Vcc - 0.5 | - | Vcc | V |
|  |  |  | Drive capacity Low | $\mathrm{IOH}=-1 \mathrm{~mA}$ | Vcc - 0.5 | - | Vcc | V |
| VoL | Output "L" voltage | $\begin{aligned} & \text { P0_4, P1, P3_0, } \\ & \text { P3_1, P3_3 to P3_5, } \\ & \text { P3_7, P4_3 to P4_5 } \end{aligned}$ | Drive capacity High | $\mathrm{IOL}=5 \mathrm{~mA}$ | - | - | 0.5 | V |
|  |  |  | Drive capacity Low | $\mathrm{IOL}=1 \mathrm{~mA}$ | - | - | 0.5 | V |
| $\mathrm{V}_{\text {T+- }} \mathrm{V}$ T- | Hysteresis | $\overline{\mathrm{INTO}}, \overline{\mathrm{INT}}, \overline{\mathrm{INT3}}, \overline{\mathrm{KIO}}$, $\overline{\mathrm{KI} 1}, \overline{\mathrm{KI2}}, \overline{\mathrm{KI} 3}, \overline{\mathrm{~K} I 4}$, $\overline{\mathrm{KI6}}, \mathrm{KI7}$, TRAIO, TRCIOA, TRCIOB, TRCIOC, TRCIOD, TRCTRG, TRCCLK, RXDO, CLKO, SSI, SCL, SDA, SSO | $\mathrm{VCC}=3.0 \mathrm{~V}$ |  | 0.1 | 0.4 | - | V |
|  |  | RESET | $\mathrm{VCC}=3.0 \mathrm{~V}$ |  | 0.1 | 0.5 | - | V |
| IIH | Input "H" current |  | V = $=3 \mathrm{~V}, \mathrm{Vcc}=3.0 \mathrm{~V}$ |  | - | - | 4.0 | $\mu \mathrm{A}$ |
| IIL | Input "L" current |  | V I $=0 \mathrm{~V}, \mathrm{Vcc}=3.0 \mathrm{~V}$ |  | - | - | -4.0 | $\mu \mathrm{A}$ |
| Rpullup | Pull-up resistance |  | $\mathrm{VI}=0 \mathrm{~V}, \mathrm{Vcc}=3.0 \mathrm{~V}$ |  | 42 | 84 | 168 | $\mathrm{k} \Omega$ |
| Rfxin | Feedback resistance | XIN |  |  | - | 0.3 | - | $\mathrm{M} \Omega$ |
| RfXCIN | Feedback resistance | XCIN |  |  | - | 8 | - | $\mathrm{M} \Omega$ |
| Vram | RAM hold voltage |  | During stop mode |  | 1.8 | - | 3.6 | V |

Note:

1. 2.7 $\mathrm{V} \leq \mathrm{VCc} \leq 3.6 \mathrm{~V}$, Topr $=-20^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$, and $\mathrm{f}(\mathrm{XIN})=16 \mathrm{MHz}$, unless otherwise specified.

Timing requirements $\quad\left(\mathrm{VCC}=3 \mathrm{~V}\right.$, Topr $=-20^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$, unless otherwise specified)
Table 5.15 TRAIO Input

| Symbol | Parameter | Standard |  | Unit |
| :--- | :--- | :---: | :---: | :---: |
|  |  | Min. | Max. |  |
| tc(TRAIO) | TRAIO input cycle time | 300 | - | ns |
| twH(TRAIO) | TRAIO input "H" width | 120 | - | ns |
| twL(TRAIO) | TRAIO input "L" width | 120 | - | ns |



Figure 5.8 TRAIO Input Timing Diagram when Vcc = 3 V

Table 5.16 Serial Interface

| Symbol | Parameter |  | Standard |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Max. |  |
| tc(CK) | CLK0 input cycle time | When an external clock is selected | 300 | - | ns |
| tw(CKH) | CLK0 input "H" width |  | 150 | - | ns |
| tw(CKL) | CLKO Input "L" width |  | 150 | - | ns |
| td(C-Q) | TXD0 output delay time |  | - | 120 | ns |
| $\operatorname{th}(\mathrm{C}-\mathrm{Q})$ | TXD0 hold time |  | 0 | - | ns |
| tsu(D-C) | RXD0 input setup time |  | 30 | - | ns |
| th(C-D) | RXD0 input hold time |  | 90 | - | ns |
| th(C-Q) | TXD0 output delay time | When an internal clock is selected | - | 30 | ns |
| tsu(D-C) | RXD0 input setup time |  | 120 | - | ns |
| th(C-D) | RXD0 input hold time |  | 90 | - | ns |



Figure 5.9 Serial Interface Timing Diagram when Vcc $=3 \mathrm{~V}$

Table 5.17 External Interrupt $\overline{\mathrm{INTi}}(\mathbf{i}=\mathbf{0}, \mathbf{1}, 3)$ Input, Key Input Interrupt $\overline{\mathrm{KII}} \mathbf{( i = 0}$ to $\mathbf{7})$

| Symbol | Parameter | Standard |  | Unit |
| :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Max. |  |
| tw(INH) | $\overline{\mathrm{INTi}}$ input "H" width, $\overline{\mathrm{Kli}}$ input "H" width | 380 (1) | - | ns |
| tW(INL) |  | 380 (2) | - | ns |

Notes:

1. When selecting the digital filter by the $\overline{\mathrm{INTi}}$ input filter select bit, use an $\overline{\mathrm{INTi}}$ input HIGH width of either ( $1 /$ digital filter clock frequency $\times 3$ ) or the minimum value of standard, whichever is greater.
2. When selecting the digital filter by the $\overline{\mathrm{INTi}}$ input filter select bit, use an $\overline{\mathrm{INTi}}$ input LOW width of either (1/digital filter clock frequency $\times 3$ ) or the minimum value of standard, whichever is greater.


Figure 5.10 Input Timing Diagram for External Interrupt $\overline{\mathrm{INTi}}$ and Key Input Interrupt $\overline{\mathrm{KII}}$ when Vcc = 3 V

Table 5.18 Electrical Characteristics (3) [1.8 V $\leq$ Vcc $<2.7 \mathrm{~V}]$

| Symbol | Parameter |  | Condition |  | Standard |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. |  |
| VOH | Output "H" voltage | $\begin{array}{\|l} \hline \text { P0_4, P1, P3_0, } \\ \text { P3_1, P3_3 to P3_5, } \\ \text { P3_7, P4_3 to P4_5 } \\ \hline \end{array}$ |  |  | Drive capacity High | $\mathrm{IOH}=-2 \mathrm{~mA}$ | Vcc - 0.5 | - | Vcc | V |
|  |  |  | Drive capacity Low | $\mathrm{IOH}=-1 \mathrm{~mA}$ | Vcc-0.5 | - | Vcc | V |
| VoL | Output "L" voltage | $\begin{array}{\|l} \hline \text { P0_4, P1, P3_0, } \\ \text { P3_1, P3_3 to P3_5, } \\ \text { P3_7, P4_3 to P4_5 } \\ \hline \end{array}$ | Drive capacity High | $\mathrm{IOL}=2 \mathrm{~mA}$ | - | - | 0.5 | V |
|  |  |  | Drive capacity Low | $\mathrm{IOL}=1 \mathrm{~mA}$ | - | - | 0.5 | V |
| $\mathrm{V}^{\text {+ }+-\mathrm{V}}$ - | Hysteresis | $\begin{aligned} & \overline{\overline{\mathrm{INTO}},} \overline{\mathrm{INT1}}, \overline{\mathrm{INT3}}, \overline{\mathrm{KIO}}, \\ & \overline{\mathrm{KI1}}, \overline{\mathrm{KI2},}, \overline{\mathrm{KI3}}, \overline{\mathrm{KI4}}, \\ & \overline{\mathrm{KIG},}, \\ & \mathrm{TRCIT}, \text { TRAIO, TRCIOB, } \\ & \text { TRCIOC, TRCIOD, } \\ & \text { TRCTRG, TRCCLK, } \\ & \text { RXDO, CLKO, SSI, } \\ & \text { SCL, SDA, SSO } \end{aligned}$ | $\mathrm{VCC}=2.2 \mathrm{~V}$ |  | 0.05 | 0.20 | - | V |
|  |  | RESET | $\mathrm{VCC}=2.2 \mathrm{~V}$ |  | 0.05 | 0.20 | - | V |
| IIH | Input "H" current |  | $\mathrm{VI}=2.2 \mathrm{~V}, \mathrm{Vcc}=2.2 \mathrm{~V}$ |  | - | - | 4.0 | $\mu \mathrm{A}$ |
| IIL | Input "L" current |  | $\mathrm{V}=0 \mathrm{~V}, \mathrm{Vcc}=2.2 \mathrm{~V}$ |  | - | - | -4.0 | $\mu \mathrm{A}$ |
| Rpullup | Pull-up resistance |  | V I $=0 \mathrm{~V}, \mathrm{Vcc}=2.2 \mathrm{~V}$ |  | 70 | 140 | 300 | $\mathrm{k} \Omega$ |
| Rfxin | Feedback resistance | XIN |  |  | - | 0.3 | - | $\mathrm{M} \Omega$ |
| RfxCIn | Feedback resistance | XCIN |  |  | - | 8 | - | $\mathrm{M} \Omega$ |
| Vram | RAM hold voltage |  | During stop mode |  | 1.8 | - | 3.6 | V |

Note:

1. $1.8 \mathrm{~V} \leq \mathrm{Vcc}<2.7 \mathrm{~V}$, $\mathrm{T}_{\text {opr }}=-20^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$, and $\mathrm{f}(\mathrm{XIN})=16 \mathrm{MHz}$, unless otherwise specified.

Timing requirements $\quad\left(\mathrm{Vcc}=2.2 \mathrm{~V}\right.$, Topr $=-20^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$, unless otherwise specified)
Table 5.19 TRAIO Input

| Symbol | Parameter | Standard |  | Unit |
| :--- | :--- | :---: | :---: | :---: |
|  |  | Min. | Max. |  |
| tc(TRAIO) | TRAIO input cycle time | 500 | - | ns |
| twH(TRAIO) | TRAIO input "H" width | 200 | - | ns |
| twL(TRAIO) | TRAIO input "L" width | 200 | - | $n s$ |



Figure 5.11 TRAIO Input Timing Diagram when Vcc = 2.2 V

Table 5.20 Serial Interface

| Symbol | Parameter |  | Standard |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Max. |  |
| tc(CK) | CLK0 input cycle time | When an external clock is selected | 800 | - | ns |
| tw(CKH) | CLK0 input "H" width |  | 400 | - | ns |
| tw(CKL) | CLK0 input "L" width |  | 400 | - | ns |
| td(C-Q) | TXD0 output delay time |  | - | 200 | ns |
| $\operatorname{th}(\mathrm{C}-\mathrm{Q})$ | TXD0 hold time |  | 0 | - | ns |
| tsu(D-C) | RXD0 input setup time |  | 150 | - | ns |
| th(C-D) | RXD0 input hold time |  | 90 | - | ns |
| th(C-Q) | TXD0 output delay time | When an internal clock is selected | - | 200 | ns |
| tsu(D-C) | RXD0 input setup time |  | 150 | - | ns |
| th(C-D) | RXD0 input hold time |  | 90 | - | ns |



Figure 5.12 Serial Interface Timing Diagram when Vcc $=2.2 \mathrm{~V}$

Table 5.21 External Interrupt $\overline{\mathrm{INTi}}(\mathbf{i}=\mathbf{0}, \mathbf{1}, 3)$ Input, Key Input Interrupt $\overline{\mathrm{KII}} \mathbf{( i = 0}$ to $\mathbf{7})$

| Symbol | Parameter | Standard |  | Unit |
| :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Max. |  |
| tw(INH) | $\overline{\text { INTi input "H" width, } \overline{\mathrm{Kli}} \text { input "H" width }}$ | $1000{ }^{(1)}$ | - | ns |
| tW(INL) |  | 1000 (2) | - | ns |

Notes:

1. When selecting the digital filter by the $\overline{\mathrm{INTi}}$ input filter select bit, use an $\overline{\mathrm{INTi}}$ input HIGH width of either ( $1 /$ digital filter clock frequency $\times 3$ ) or the minimum value of standard, whichever is greater.
2. When selecting the digital filter by the $\overline{\mathrm{INTi}}$ input filter select bit, use an $\overline{\mathrm{NTI}}$ input LOW width of either (1/digital filter clock frequency $\times 3$ ) or the minimum value of standard, whichever is greater.


Figure 5.13 Input Timing Diagram for External Interrupt $\overline{\mathrm{INTi}}$ and Key Input Interrupt $\overline{\mathrm{KII}}$ when $\mathrm{Vcc}=2.2 \mathrm{~V}$

Table 5.22 Transceiver Transmission Characteristics
(VCC = VCCRF $=3.3 \mathrm{~V}$, Topr $=25^{\circ} \mathrm{C}$, unless otherwise specified)

| Parameter |  | Condition | Standard |  |  | IEEE802.15.4 standard | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |  |
| Internal voltage |  |  |  | - | 1.45 | - | - | V |
| Nominal output power |  |  | -3 | 0 | 3 | -3 or more | dBm |
| Transmit bit rate |  |  | - | 250 | - | 250 | kbps |
| Transmit chip rate |  |  | - | 2000 | - | 2000 | kchips/s |
| Programmable output power range |  | 32 steps | - | 32 | - | 32 steps | dB |
| Harmonics | 2nd harmonics | External notch filter | - | - | -47.2 | -41.2 or less | dBm |
|  | 3rd harmonics |  | - | - | -47.2 | - |  |
| Spurious emission | $30-88 \mathrm{MHz}$ | Maximum output power, Renesas evaluation board | - | - | -55.2 | FCC | dBm |
|  | $88-216 \mathrm{MHz}$ |  | - | - | -51.7 | FCC |  |
|  | $216-960 \mathrm{MHz}$ |  | - | - | -49.2 | FCC |  |
|  | $960-1000 \mathrm{MHz}$ |  | - | - | -41.2 | FCC |  |
|  | $1-12.75 \mathrm{GHz}$ |  | - | - | -41.2 | FCC (1) |  |
|  | $1.8-1.9 \mathrm{GHz}$ |  | - | - | -47 | ETSI |  |
|  | $5.15-5.3 \mathrm{GHz}$ |  | - | - | -47 | ETSI |  |
| Error vector magnitude EVM |  | 1000 chips | - | - | 35 | 35 or less | \% |
| Power spectral density | Absolute limit | $\|\mathrm{f}-\mathrm{fc}\|>3.5 \mathrm{MHz}$ | - | - | -30 | -30 or less | dBm |
|  | Relative limit | \|f-fc| $>3.5 \mathrm{MHz}$ | - | - | -20 | -20 or less | dB |
| Frequency tolerance |  | Including crystal $\pm 20 \mathrm{ppm}$ | -40 | - | 40 | Within $\pm 40$ | ppm |

Note:

1. Notes on FFC certification testing

When using $26 \mathrm{CH}(2480 \mathrm{MHz})$, adjust the transmit power to meet the FCC requirements and standards at 2483.5 MHz .
Table 5.23 Transceiver Reception Characteristics
(VCC = VCCRF = 3.3 V, Topr $=25^{\circ} \mathrm{C}$, unless otherwise specified)

| Parameter |  | Condition | Standard |  |  | IEEE802.15.4 standard | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |  |  |
| Internal voltage |  |  |  | - | 1.45 | - | - | V |
| RF input frequency |  |  | 2405 | - | 2480 | Min. 2405/ <br> Max. 2480 | MHz |
| Receiver sensitivity |  | $\begin{aligned} & \hline \text { PER = 1\% } \\ & \text { PSDU } \\ & \text { Length = 20 octets } \\ & \text { Interframe spacing } \\ & 12 \text { symbols } \\ & \text { (IEEE802.15.4 } \\ & \text { minimum spacing) } \end{aligned}$ | - | -95 | -85 | -85 or less | dBm |
| Maximum input level |  | PER $=1 \%$ | 0 | - | - | -20 or more | dBm |
| Adjacent channel rejection | $+5 \mathrm{MHz}$ | $\begin{array}{\|l\|} \hline \text { PER }=1 \% \\ \text { Prf }=-82 \mathrm{dBm} \end{array}$ | 0 | - | - | 0 or more | dB |
|  | -5 MHz |  | 0 | - | - |  |  |
| Alternate channel rejection | $+10 \mathrm{MHz}$ | $\begin{array}{\|l} \hline \text { PER }=1 \% \\ \text { Prf }=-82 \mathrm{dBm} \end{array}$ | 30 | - | - | 30 or more | dB |
|  | -10 MHz |  | 30 | - | - |  |  |
| Rejection | $>+15 \mathrm{MHz}$ | $\begin{aligned} & \text { PER = } 1 \% \\ & \text { Prf }=-82 \mathrm{dBm} \end{aligned}$ | 30 | - | - | - | dB |
|  | $<-15 \mathrm{MHz}$ |  | 30 | - | - |  |  |
| Spurious emission | $30-1000 \mathrm{MHz}$ | Renesas evaluation board | - | - | -57 | ETSI EN300/328 | dBm |
|  | $1-12.75 \mathrm{GHz}$ |  | - | - | -47 |  |  |
| Symbol error tolerance |  |  | -80 | - | 80 | $\pm 80$ or less | ppm |
| RSSI range |  | Prf (min) $=-75 \mathrm{dBm}$ | 40 | 75 | - | 40 or more | dB |
| RSSI accuracy |  | Prf $=-75$ to -35 dBm | -6 | - | 6 | Within $\pm 6$ | dB |

## Package Dimensions

Diagrams showing the latest package dimensions and mounting information are available in the "Packages" section of the Renesas Electronics website.


## REVISION HISTORY R8C/3MQ Group Datasheet

| Rev. | Date | Description |  |  |
| :---: | :---: | :---: | :--- | :---: |
|  |  | Page | Summary |  |
| 0.10 | Nov 19, 2010 | - | First Edition issued |  |
| 1.00 | Aug 11, 2011 | All pages | "Preliminary", "Under development" deleted |  |
|  |  | 4 | Table 1.2 revised, Note 1 added |  |
|  |  | 5 | Table 1.3 "(D): Under development", (P): Under planning" deleted |  |
|  |  | 6 | Figure 1.2 revised |  |
|  |  | 7 | Figure 1.3 revised |  |
|  |  | 9,10 | Table 1.5, Table 1.6 revised |  |
|  |  | 12 | 2.4 revised |  |
|  |  | 14 | 3.1 revised |  |
|  |  | 16,17 | Table 4.2, Table 4.3 revised |  |
|  |  | 19 | Table 4.5 Note 2 added |  |
|  |  | 20 | Table 4.6 revised |  |
|  |  | 24,25 | Table 4.10, Table 4.11 revised |  |
|  |  | 32 | Table 5.6 revised |  |
|  |  | 39 | Table 5.13 revised |  |
|  |  | 46 | Table 5.22, Table 5.23 revised, Table 5.22 Note 1 added |  |
|  |  |  |  |  |

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## General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this manual, refer to the relevant sections of the manual. If the descriptions under General Precautions in the Handling of MPU/MCU Products and in the body of the manual differ from each other, the description in the body of the manual takes precedence.

1. Handling of Unused Pins

Handle unused pins in accord with the directions given under Handling of Unused Pins in the manual.

- The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

- The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.
In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

- The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

- When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

Before changing from one product to another, i.e. to one with a different part number, confirm that the change will not lead to problems.

- The characteristics of MPU/MCU in the same group but having different part numbers may differ because of the differences in internal memory capacity and layout pattern. When changing to products of different part numbers, implement a system-evaluation test for each of the products.


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